# **MDS-M100**

# **SERVICE MANUAL**



US Model Canadian Model AEP Model UK Model E Model



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Model Name Using Similar Mechanism	MDS-JE520
MD Mechanism Type	MDM-5A
Optical Pick-up Type	KMS-260A/J1N

#### **SPECIFICATIONS**

System	MiniDisc digital	audio system

Disc MiniDisc

Laser Semiconductor laser ( $\lambda = 780 \text{ nm}$ )

Emission duration: continuous

Laser output Less than 44.6 µW\*

\*This output is the value measured at a distance of 200 mm from the objective lens surface on the Optical Pick-up Block with 7 mm aperture.

Laser diode Material: GaAlAs

Revolutions (CLV) 400 rpm to 900 rpm

Error correction Advanced Cross Interleave Reed

Solomon Code (ACIRC)

Sampling frequency 44.1 kHz

Coding Adaptive Transform Acoustic Coding

(ATRAC)

Modulation system EFM (Eight-to-Fourteen Modulation)

Number of channels 2 stereo channels

Frequency response 5 to 20,000 Hz ±0.3 dB

Signal-to-noise ratio Over 98 dB during playback

Wow and flutter Below measurable limit

#### Inputs

LINE (ANALOG) IN Jack type: phono

Impedance: 47 kilohms
Rated input: 500 mVrms
Minimum input: 125 mVrms

DIGITAL IN Connector type: square optical

Impedance: 660 nm (optical wave

length)

Outputs

LINE (ANALOG) OUT Jack type: phono

Rated output: 2 Vrms (at 50 kilohms) Load impedance: Over 10 kilohms

- Continued on next page -

MINIDISC DECK





#### General

#### **Power requirements**

Mass (approx.)

Where purchased	Power requirements			
U.S.A. and Canada		120 V AC, 60 Hz		
U.K. and Continental Eu	rope	220 - 230 V AC, 50/60 Hz		
Other countries		110 - 120 or 220 - 240 V AC selectable, 50/60 Hz		
Power consumption	15 W	7		
Dimensions (approx.)		$3.5 \times 9.5 \times 345$ mm (w/h/d) incl. projecting parts and controls		

3.7 kg

#### **Supplied accessories**

- Audio connecting cords (2)
- Optical cable (1)
- Remote commander (remote) RM-D30P (1)
- R6 (size-AA) batteries (2)

Design and specifications are subject to change without notice.

#### **SELF-DIAGNOSIS FUNCTION**

The self-diagnosis function consists of error codes for customers which are displayed automatically when errors occur, and error codes which show the error history in the test mode during servicing. For details on how to view error codes for the customer, refer to the following box in the instruction manual. For details on how to check error codes during servicing, refer to the following "Procedure for using the Self-Diagnosis Function (Error History Display Mode)".

### **Self-Diagnosis Function**

The deck's self-diagnosis function automatically checks the condition of the MD deck when an error occurs, then issues a three-digit code and an error message on the display. If the code and message alternate, find them in the following table and perform the indicated countermeasure. Should the problem persist, consult your nearest Sony dealer.

Three-digit code/Message	Cause/Remedy
C11/Protected	The inserted MD is record-protected.  → Take out the MD and close the record-protect slot (page 15).
C13/REC Error	The recording was not made properly.  → Set the deck in a stable surface, and repeat the recording procedure.
	The inserted MD is dirty (with smudges, fingerprints, etc.), scratched, or substandard in quality.  Replace the disc and repeat the recording procedure.
C13/Disc Error	The deck could not read the TOC on the MD properly.  → Take out the MD and insert it again.
C14/Disc Error	The deck could not read the TOC on the MD properly.  → Insert another disc.  → If possible, erase all the tracks on the MD (page 30).
C71/Din Unlock	The sporadic appearance of this message is caused by the digital signal being recorded. This will not affect the recording.
	While recording from a digital component connected through the DIGITAL IN connector, the digital connecting cable was unplugged or the digital component turned off.  → Connect the cable or turn the digital component back on.

#### PROCEDURE FOR USING THE SELF-DIAGNOSIS FUNCTION (ERROR HISTORY DISPLAY MODE)

Note: Perform the self-diagnosis function in the "error history display mode" in the test mode. The following describes the least required procedure. Be careful not to enter other modes by mistake. If you set other modes accidentally, press the MENU/NO button to exit the mode.

- 1. While pressing the ▲ AMS ▶ knob and button, connect the power plug to the outlet, and release the ▲ AMS ▶ knob and button.
- 2. Turn the ★★ AMS ★★ knob and when "[Service]" is displayed, press the YES button.
- 3. Turn the AMS knob to display "ERR DP MODE".
- 4. Press the YES button to sets the error history mode and displays "total rec".
- 5. Select the contents to be displayed or executed using the AMS knob.
- 6. Press the AMS knob to display or execute the contents selected.
- 7. Press the AMS knob another time returns to step 4.
- 8. Press the MENU/NO button to display "ERROR DP MODE" and exits the error history mode.
- 9. To exit the test mode, press the REPEAT button. The unit sets into the STANDBY state, the disc is ejected, and the test mode ends.

# Items of Error History Mode Items and Contents Selecting the Test Mode

Display	Details of History
total rec	Displays the recording time. Displayed as "r \( \subseteq \subsete
total play	Displays the play time. Displayed as "p\\\ \Box\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
retry err	Displays the total number of retries during recording and number of retry errors during play.  Displayed as "r p p recording while "p" indicates the retry errors during play.  The number of retries and retry errors are displayed in hexadecimal digits from 00 to FF.
total err	Displays the total number of errors.  Displayed as "total □□".  The number of errors is displayed in hexadecimal digits from 00 to FF.
err history	Displays the 10 latest errors.  Displayed as "0□ E@@".  □ indicates the history number. The smaller the number, the more recent is the error. (00 is the latest).  @@ indicates the error code.  Refer to the following table for the details. The error history can be switched by turning the     Image: AMS
er refresh	Mode which erases the "retry err", "total err", and "err history" histories.  When returning the unit to the customer after completing repairs, perform this to erase the past error history.  After pressing the AMS button and "er refresh?" is displayed, press the YES button to erase the history.  "Complete!" will be displayed momentarily.  Be sure to check the following when this mode has been executed.  • The data has been erased.  • The mechanism operates normally when recording and play are performed.
tm refresh	Mode which erases the "total rec" and "total play" histories.  These histories serve as approximate indications of when to replace the optical pickup.  If the optical pickup has been replaced, perform this operation and erase the history.  After pressing the ► AMS ► button and "tm refresh?" is displayed, press the YES button to erase the history.  "Complete!" will be displayed momentarily.  Be sure to check the following when this mode has been executed.  • The data has been erased.  • The mechanism operates normally when recording and play are performed.

#### **Table of Error Codes**

Error Code	Details of Error	Error Code	Details of Error
E00	No error	E05	FOK has deviated
E01	Disc error. PTOC cannot be read	E06	Cannot focus (Servo has deviated)
	(DISC ejected)	E07	Recording retry
E02	Disc error. UTOC error	E08	Recording retry error
	(DISC not ejected)	E09	Playback retry error
E03	Loading error		(Access error)
E04	Address cannot be read (Servo has deviated)	E0A	Playback retry error (C2 error)

# SECTION 1 SERVICING NOTES

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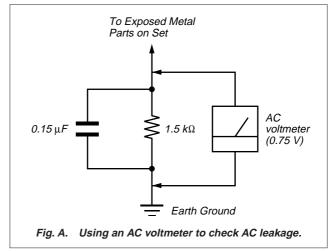
#### **SAFETY CHECK-OUT**

After correcting the original service problem, perform the following safety check before releasing the set to the customer: Check the antenna terminals, metal trim, "metallized" knobs, screws, and all other exposed metal parts for AC leakage. Check leakage as described below.

#### **LEAKAGE TEST**

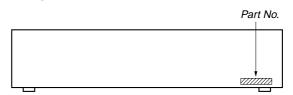
The AC leakage from any exposed metal part to earth ground and from all exposed metal parts to any exposed metal part having a return to chassis, must not exceed 0.5 mA (500 microampers). Leakage current can be measured by any one of three methods.

- A commercial leakage tester, such as the Simpson 229 or RCA WT-540A. Follow the manufacturers' instructions to use these instruments.
- 2. A battery-operated AC milliammeter. The Data Precision 245 digital multimeter is suitable for this job.
- 3. Measuring the voltage drop across a resistor by means of a VOM or battery-operated AC voltmeter. The "limit" indication is 0.75 V, so analog meters must have an accurate low-voltage scale. The Simpson 250 and Sanwa SH-63Trd are examples of a passive VOM that is suitable. Nearly all battery operated digital multimeters that have a 2 V AC range are suitable. (See Fig. A)



#### **MODEL IDENTIFICATION**

— BACK PANEL —



MODEL	Part No.
US model	4-216-840-0□
Canadian model	4-216-840-1□
Singapore model	4-216-840-2□
AEP model	4-216-840-3□
UK model	4-216-840-4□

#### **CAUTION**

Danger of explosion if battery is incorrectly replaced.

Replace only with the same or equivalent type recommended by the manufacturer.

Discard used batteries according to the manufacturer's instructions.

#### **ADVARSEL!**

Lithiumbatteri-Eksplosionsfare ved fejlagtig håndtering.
Udskiftning må kun ske med batteri
af samme fabrikat og type.
Levér det brugte batteri tilbage til leverandøren.

#### **ADVARSEL**

Eksplosjonsfare ved feilaktig skifte av batteri. Benytt samme batteritype eller en tilsvarende type anbefalt av apparatfabrikanten. Brukte batterier kasseres i henhold til fabrikantens instruksjoner.

#### **VARNING**

Explosionsfara vid felaktigt batteribyte. Använd samma batterityp eller en likvärdig typ som rekommenderas av apparattillverkaren. Kassera använt batteri enligt gällande föreskrifter.

#### **VAROITUS**

Paristo voi räjähtää, jos se on virheellisesti asennettu. Vaihda paristo ainoastaan laitevalmistajan suosittelemaan tyyppiin. Hävitä käytetty paristo valmistajan ohjeiden mukaisesti. Laser component in this product is capable of emitting radiation exceeding the limit for Class 1.

CLASS 1 LASER PRODUCT LUOKAN 1 LASERLAITE KLASS 1 LASERAPPARAT This appliance is classified as a CLASS 1 LASER product. The CLASS 1 LASER PRODUCT MARKING is located on the rear exterior.

CAUTION: INVISIBLE LASER RADIATION WHEN OPEN AND INTERLOCKS DEFEATED. AVOID EXPOSURE TO BEAM.

ADVARSEL: USYNLIG LASERSTRÄLING VED ÄBNING NÅR SKKERHEDSAFBRYDERE ER UDE AF FUNKTION. UNDGÅ UDSAETTELSE FOR STRÅLING.

VORSICHT: UNSICHTBARE LASERSTRAHLUNG, WENN ABDECKUNG GEOFFNET UND SICHEREITSVERRIEGELUNG ÜBERBRÜCKT, NICHT DEM STRAHL AUSSETZEN.

VARO!: AVATTAESSA JA SUOJALUKITUS OHTETTAESSA OLET ALTTINA NÄKYMÄTTÖMÄLLE LASERSÄTELYLLE, ÄLÄ KATSO SÄTEESSEN.

VARNING: OSYNLING LASERSTRÄLING NÄR DENNA DEL ÄR ÖPPNAD OCH SPÄRBEN ÄR URIKOPPLAD, BETRAKTA EJ STRÄLEN.

ADVERSEL: USYNLIG LASERSTRÄLING NÄR DEKSEL APNES OG SKKERHEDSLÅS BRYTES. UNNGÅ EKSPONERING FOR STRÅLEN.

VIGYAZAT!: A BURKOPLAT NYTTÄSAKOR LÄTHATATLAN LÉZERSU-GÄRVESZĖLY/ KERÜLJE A BESUGÄRZÄST/

This caution label is located inside the unit.

#### CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

#### Flexible Circuit Board Repairing

- Keep the temperature of the soldering iron around 270 °C during repairing.
- Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
- Be careful not to apply force on the conductor when soldering or unsoldering.

#### Notes on chip component replacement

- · Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

#### SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK  $\triangle$  OR DOTTED LINE WITH MARK  $\triangle$  ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

#### ATTENTION AU COMPOSANT AYANT RAPPORT À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFIÉS PAR UNE MARQUE A SUR LES DIAGRAMMES SCHÉMATIQUES ET LA LISTE DES PIÈCES SONT CRITIQUES POUR LA SÉCURITÉ DE FONCTIONNEMENT. NE REMPLACER CES COMPOSANTS QUE PAR DES PIÈCES SONY DONT LES NUMÉROS SONT DONNÉS DANS CE MANUEL OU DANS LES SUPPLÉMENTS PUBLIÉS PAR SONY.

#### JIG FOR CHECKING BD BOARD WAVEFORM

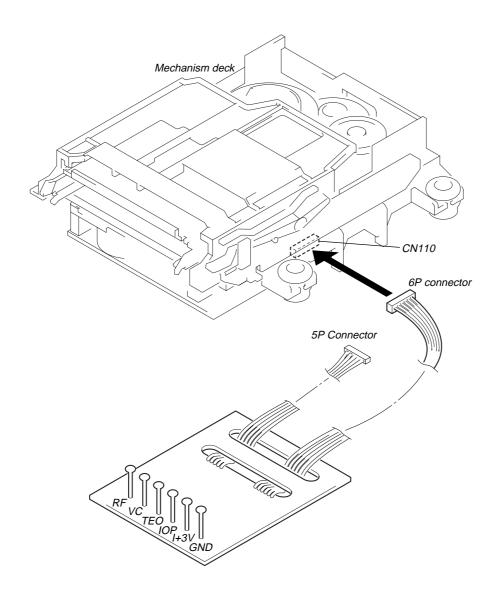
The special jig (J-2501-149-A) is useful for checking the waveform of the BD board. The names of terminals and the checking items to be performed are shown as follows.

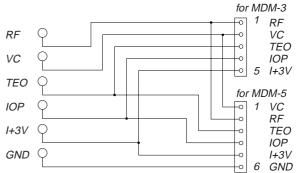
GND: Ground

I+3V : For measuring IOP (Check the deterioration of the optical pick-up laser)  $IOP\:$  : For measuring IOP (Check the deterioration of the optical pick-up laser)

TEO: TRK error signal (Traverse adjustment) VC: Reference level for checking the signal

RF : RF signal (Check jitter)





# IOP DATA RECORDING AND DISPLAY WHEN OPTICAL PICK-UP AND NON-VOLATILE MEMORY (IC171 OF BD BOARD) ARE REPLACED

The IOP value labeled on the optical pick-up can be recorded in the non-volatile memory. By recording the value, it will eliminate the need to look at the value on the label of the optical pick-up. When replacing the optical pick-up or non-volatile memory (IC171 of BD board), record the IOP value on the optical pick-up according to the following procedure.

#### **Record Precedure:**

- 1. While pressing the AMS knob and button, connect the power plug to the outlet, and release the AMS button.
- 2. Turn the AMS ▶ knob to display "[Service]", and press the YES button.
- 3. Turn the ★ AMS ★ knob to display "lop Write" (C28), and press the YES button.
- 4. The display becomes "Ref=@@@.@" (@ is an arbitrary number) and the numbers which can be changed will blink.
- Input the IOP value written on the optical pick-up.
   To select the number: Turn the AMS ► knob.
   To select the digit : Press the AMS ► knob.
- 6. When the YES button is pressed, the display becomes "Measu=@@@.@" (@ is an arbitrary number).
- 7. As the adjustment results are recorded for the 6 value. Leave it as it is and press the YES button.
- 8. "Complete!" will be displayed momentarily. The value will be recorded in the non-volatile memory and the display will become "Iop Write".
- 9. Press the REPEAT button to complete.

#### **Display Precedure:**

- 1. While pressing the ★ AMS ▶ knob and button, connect the power plug to the outlet, and release the ★ AMS ▶ knob and button.
- 2. Turn th AMS knob to display "[Service]", and press the YES button.
- 3. Turn the AMS knob to display "lop Read" (C27).
- 4. "@@.@/##.#" is displayed and the recorded contents are displayed.
  - @@.@: indicates the IOP value labeled on the optical pick-up.
  - ##.# : indicates the IOP value after adjustment
- 5. To end, press the AMS knod or MENU/NO button to display "Iop Read". Then press the REPEAT button.

#### CHECKS PRIOR TO PARTS REPLACEMENT AND ADJUSTMENTS

Before performing repairs, perform the following checks to determine the faulty locations up to a certain extent. Details of the procedures are described in "5 Electrical Adjustments".

	Criteria for Determination (Unsatisfactory if specified value is not satisfied)	Measure if unsatisfactory:				
Laser power check (6-2 : See page 23)	<ul> <li>0.9 mW power Specified value: 0.84 to 0.92 mW</li> <li>7.0 mW power Specified value: 6.8 to 7.2 mW</li> </ul>	Clean the optical pick-up     Adjust again     Replace the optical pick-up				
	lop (at 7mW)  • Labeled on the optical pickup Iop value ± 10mA	Replace the optical pick-up				
Traverse check (6-3 : See page 23)	Traverse waveform     Specified value : Below 10% offset	Replace the optical pick-up				
Focus bias check (6-4 : See page 24)	• Error rate check Specified value: For points a, b, and c C1 error: About 200 AD error: Above 00	Replace the optical pick-up				
C PLAY check (6-5 : See page 24)	Error rate check     Specified value:     a. When using test disc (MDW-74/AU-1)         C1 error : Below 80         AD error : Below 2     b. When using check disc (TDYS-1)         C1 error : Below 50	Replace the optical pick-up				
Self-recording/playback check (6-6 : See page 24)	CPLAY error rate check     Specified value:     C1 error : Below 80     AD error : Below 2	If always unsatisfactory: Replace the overwrite head Check for disconnection of the circuits around the overwrite head				
		If occasionally unsatisfactory:  • Check if the overwrite head is distorted  • Check the mechanism around the sled				
Temperature compensation offset check (6-1 : See page 23)	Unsatisfactory if displayed as T=@@ (##) [NG" NG (@@, ## are both arbitrary numbers)	Check for disconnection of the circuits around D101 (BD board)     Check the signals around IC101, IC121, CN102, CN103 (BD board)				

#### Note:

The criteria for determination above is intended merely to determine if satisfactory or not, and does not serve as the specified value for adjustments. When performing adjustments, use the specified values for adjustments.

#### **RETRY CAUSE DISPLAY MODE**

• In this test mode, the causes for retry of the unit during recording can be displayed on the fluorescent indicator tube. During playback, the "track mode" for obtaining track information will be set.

This is useful for locating the faulty part of the unit.

• The following will be displayed:

During recording and stop: Retry cause, number of retries, and number of retry errors.

During playback : Information such as type of disc played, part played, copyright.

These are displayed in hexadecimal.

#### **Precedure:**

1. Load a recordable disc whose contents can be erased into the unit.

- 2. Press the MENU/NO button. When "Edit Menu" is displayed on the fluorescent indicator tube, turn the ◀◀ AMS ▶▶ knob to display "All Erase?".
- 3. Press the YES button. (Or press the AMS knob)
- 4. When "All Erase??" is displayed on the fluorescent indicator tube, the music calendar number blinks.
- 5. Press the YES button to display "Complete!!", and press the button immediately. Wait for about 15 seconds while pressing the button. (The AMS | knob can be pressed instead of the YES button for the same results.)
- 6. When the "TOC" displayed on the fluorescent display tube goes off, release the button.
- 7. Press the REC button to start recording. Then press the button and start recording.
- 8. To check the "track mode", press the button to start play.
- 9. To exit the test mode, press the 🔟 button, and turn OFF the power. When "TOC" disappears, disconnect the power plug from the outlet.

# Fig. 1 Reading the Test Mode Display (During recording and stop)

RTs@@c##e\*\*

Fluorescent display tube display

@ @ : Cause of retry## : Number of retries\*\* : Number of retry errors

## Fig. 2 Reading the Test Mode Display (During playback)

@@####\*\*\$\$

Fluorescent display tube display

@@: Parts No. (name of area named on TOC)

\$\$ : Track mode (Track information such as copy-

right information of each part)

#### Reading the Retry Cause Display

	Hi	ighe	er B	its	Lo	owe	r Bi	ts	Hexa-			
Hexadecimal	8	4	2	1	8	4	2	1	decimal	Cause of Retry	Occurring conditions	
Bit	b7	b6	b5	b4	b3	b2	b1	b0				
Binary	0	0	0	0	0	0	0	1	01	shock	When track jump (shock) is detected	
	0	0	0	0	0	0	1	0	02	ader5	When ADER was counted more than five times continuously	
	0	0	0	0	0	1	0	0	04	Discontinuous address	When ADIP address is not continuous	
	0	0	0	0	1	0	0	0	08	DIN unlock	When DIN unlock is detected	
	0	0	0	1	0	0	0	0	10	FCS incorrect	When not in focus	
	0	0	1	0	0	0	0	0	20	IVR rec error	When ABCD signal level exceeds the specified range	
	0	1	0	0	0	0	0	0	40	CLV unlock	When CLV is unlocked	
	1	0	0	0	0	0	0	0	80	Access fault	When access operation is not performed normally	

#### Reading the Display:

Convert the hexadecimal display into binary display. If more than two causes, they will be added.

#### Example

When 42 is displayed:

Higher bit:  $4 = 0100 \rightarrow b6$ Lower bit:  $2 = 0010 \rightarrow b1$ 

In this case, the retry cause is combined of "CLV unlock" and "ader5".

When A2 is displayed:

Higher bit:  $A = 1010 \rightarrow b7+b5$ Lower bit:  $2 = 0010 \rightarrow b1$ 

The retry cause in this case is combined of "access fault", "IVR rec error", and "ader5".

#### Reading the Retry Cause Display

	Hi	ghe	r B	its	Lo	we	r Bi	ts	Hexa-	Details	
Hexadecimal	8	4	2	1	8	4	2	1	decimal	Det	alls
Bit	b7	b6	b5	b4	b3	b2	b1	b0		When 0	When 1
Binary	0	0	0	0	0	0	0	1	01	Emphasis OFF	Emphasis ON
	0	0	0	0	0	0	1	0	02	Monaural	Stereo
	0	0	0	0	0	1	0	0	04	This is 2-bit display. Normally 01.	
	0	0	0	0	1	0	0	0	08	01:Normal audio. Others:Invalid	
	0	0	0	1	0	0	0	0	10	Audio (Normal)	Invalid
	0	0	1	0	0	0	0	0	20	Original Digital copy	
	0	1	0	0	0	0	0	0	40	Copyright No copyright	
	1	0	0	0	0	0	0	0	80	Write prohibited Write allowed	

#### Reading the Display:

Convert the hexadecimal display into binary display. If more than two causes, they will be added.

#### Example When 84 is displayed:

Higher bit:  $8 = 1000 \rightarrow b7$ Lower bit:  $4 = 0100 \rightarrow b2$ 

In this case, as b2 and b7 are 1 and others are 0, it can be determined that the retry cause is combined of "emphasis OFF", "monaural", "original", "copyright exists", and "write allowed".

#### Example When 07 is displayed:

Higher bit:  $0 = 1000 \rightarrow All \ 0$ Lower bit:  $7 = 0111 \rightarrow b0+b1+b2$ 

In this case, as b0, b1, and b2 are 1 and others are 0, it can be determined that the retry cause is combined of "emphasis ON", "stereo", "original", "copyright exists", and "write prohibited".

#### Hexadecimal → Binary Conversion Table

Hexadecimal	Binary	Hexadecimal	Binary
0	0000	8	1000
1	0001	9	1001
2	0010	A	1010
3	0011	В	1011
4	0100	С	1100
5	0101	D	1101
6	0110	Е	1110
7	0111	F	1111

#### **Front Panel Parts** Description

#### 1 1/0 (power) switch (14, 21)

Press to turn the deck on. When you turn the deck on, the switch indicator changes from red to green. When you press the switch again, the deck turns off and the indicator changes to red.

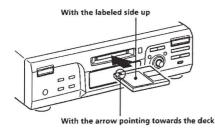
#### 2 SCROLL button (12)

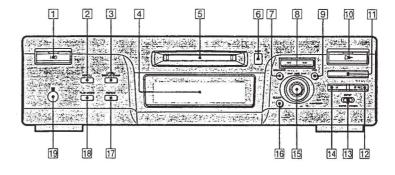
Press to scroll the name of a track or MD.

#### 3 LEVEL/DISPLAY/CHAR button (12, 16, 25, 33)

- · Press during recording pause to adjust the recording level (in the case of analog recording).
- · Press when the deck is stopped to display disc information or the contents of a program
- · Press during recording to display information on the track being recorded.
- · Press during play to display information on the current track
- · Press while editing an MD to select the type of characters to be input
- 4 Display window (11, 12) Shows various information.

#### 5 MD insertion slot (14, 21) Insert the MD as illustrated below.





#### 6 EJECT ⇒ button (15, 21)

Press to eject the MD

#### 7 MENU/NO button (14, 29, 38)

Press to display "Edit Menu" or "Setup Menu."

#### ◄◄/▶► buttons (23, 25, 30, 33)

Press to locate a portion within a track, change the contents of a program, or change the input character.

#### 9 YES button (14, 25, 29, 38)

Press to carry out the selected operation.

#### 10 > button (15, 21)

Press to start play

#### 11 button (15, 21, 29)

Press to stop play or recording or cancel the selected operation.

#### 12 •REC button (15-17)

Press to record on the MD, monitor the input signal, or mark track numbers.

#### 13 INPUT switch (14)

Use to select the input jack (or connector) of the program source to be recorded.

#### 14 11 button (15, 21)

Press to pause play or recording. Press again to resume play or recording.

#### 15 AMS control (14-16, 21, 25, 29, 33, 38)

Turn to locate tracks, adjust the recording level, select the input characters, or select a menu item.

#### [16] CLEAR button (26, 44)

Press to cancel the selection.

#### 17 REPEAT button (23, 24)

Press to play tracks repeatedly.

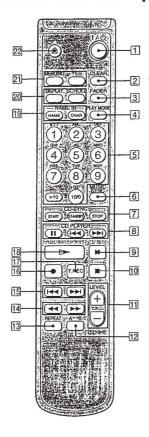
#### 18 PLAY MODE button (24)

Press to select Shuffle Play or Program Play.

#### 19 Remote sensor (4)

Point the remote towards this window ( ) for remote operations.

#### **Remote Parts Description**



#### 1 1/0 (power) switch (14, 21)

Press to turn the deck on. When you turn the deck on, the I/O switch indicator on the deck changes from red to green. When you press the switch again, the deck turns off and the indicator changes to red.

#### 2 CLEAR button (26, 34)

Press to cancel the selection.

#### 3 FADER button (37)

Press to perform Fade-in Play/Recording or Fade-out Play/Recording.

#### 4 PLAY MODE button (24)

Press to select Shuffle Play or Program Play.

#### [5] Letter/number buttons (22, 34)

Press to input letters or numbers.

### 6 MUSIC SYNC button (19)

Press to start Music Synchro-recording.

#### 7 CD-SYNC START button (19)

Press to start CD Synchro-recording.

#### CD-SYNC STANDBY button (19)

Press to enter standby for CD Synchro-recording.

#### CD-SYNC STOP button (20)

Press to stop CD Synchro-recording.

#### 8 CD PLAYER II button (20)

Press to pause the CD play. Press again to resume CD

#### CD PLAYER I◄◄/►►I buttons (20)

Press to locate tracks on the CD.

#### 9 II button (15, 21)

Press to pause play or recording. Press again to resume play or recording.

#### 10 m button (15, 21, 29)

Press to stop play, stop recording, or cancel the selected operation.

#### 11 LEVEL +/- buttons (16)

Press to adjust the recording level during analog recording.

12 A↔B button (24) Press to select Repeat A-B Play.

#### 13 REPEAT button (23, 24)

Press to play tracks repeatedly.

#### 14 </> > buttons (23, 25, 30, 34)

Press to locate a portion within a track, change the contents of a program, or shift the cursor to the right.

#### 15 I◄</▶► buttons (14-16, 21, 25, 29, 34, 38)

Press to locate tracks, adjust the recording level, or select a menu item.

#### 16 • button (15-17)

Press to record on the MD, monitor the input signal, or mark track numbers.

#### 17 T.REC button (18)

Press to start Time Machine Recording.

#### 18 > button (15, 21)

Press to start play.

#### 19 NAME button (34)

Press to add the name or change the name of a track or MD.

#### CHAR button (34)

Press to select the type of characters to be input.

#### 20 DISPLAY button (12, 16, 25)

Press to select the information to be displayed in the window.

#### SCROLL button (12)

Press to scroll the name of a track or MD.

#### 21 MENU/NO button (14, 29, 38)

Press to display "Edit Menu" or "Setup Menu." YES button (14, 25, 29, 38)

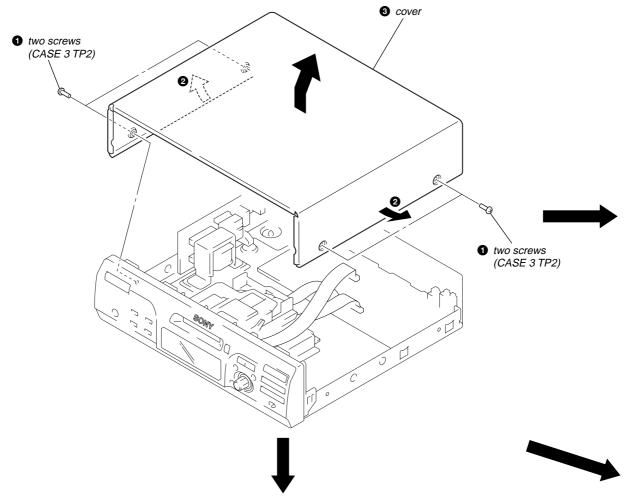
#### Press to carry out the selected operation.

Press to eject the MD.

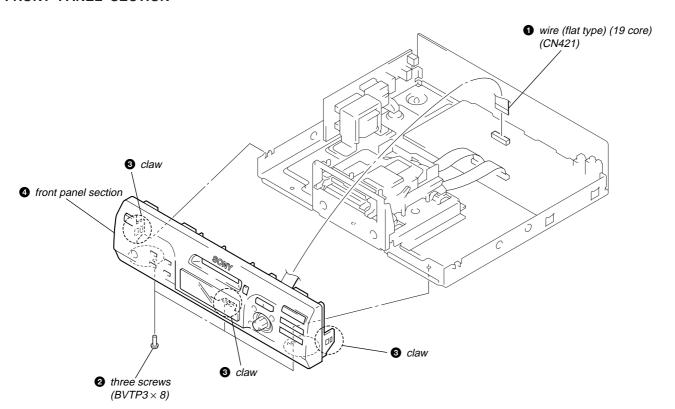
# SECTION 3 DISASSEMBLY

**Note:** Follow the disassembly procedure in the numerical order given.

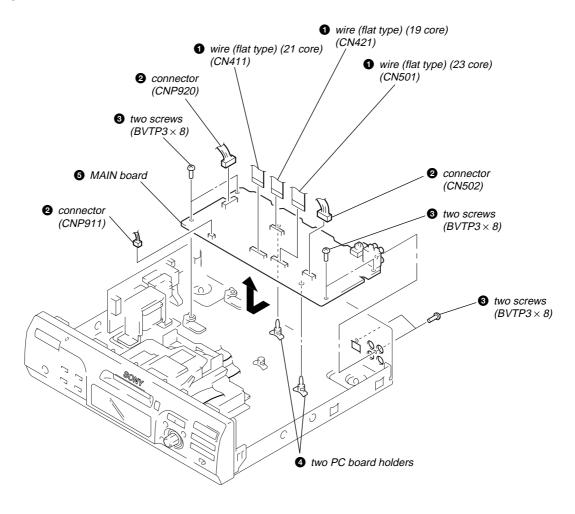
#### **COVER**



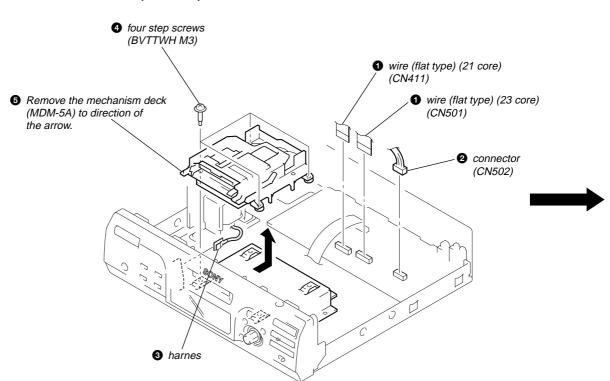
#### FRONT PANEL SECTION



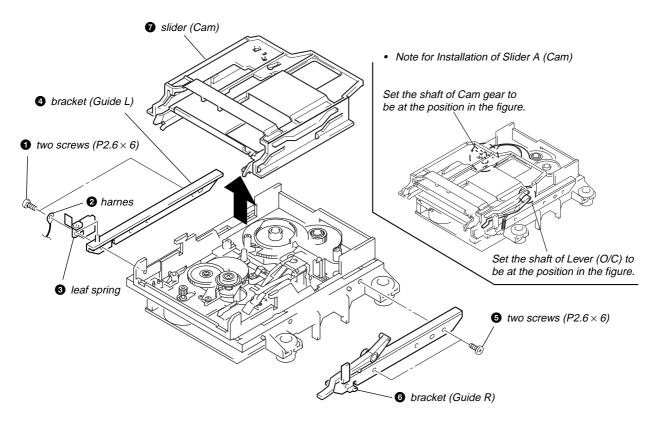
#### MAIN BOARD



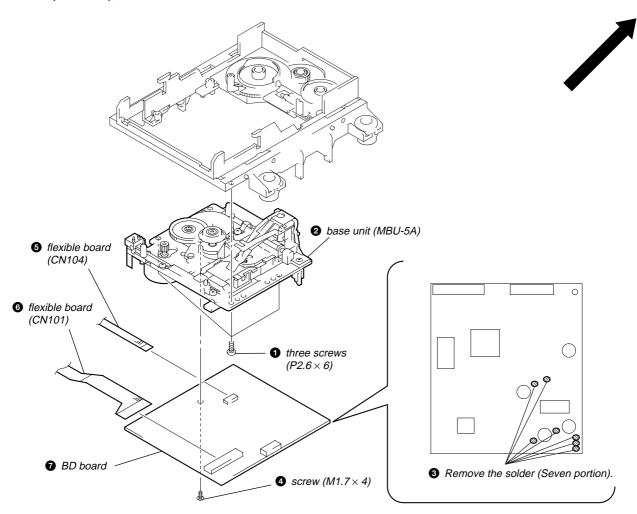
#### MECHANISM DECK SECTION (MDM-5A)



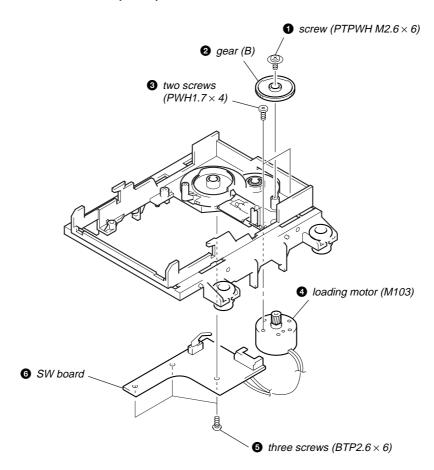
#### SLIDER (CAM)



#### BASE UNIT (MBU-5A), BD BOARD



#### SW BOARD, LOADING MOTOR (M103)



# SECTION 4 TEST MODE

#### 1. PRECAUTIONS FOR USE OF TEST MODE

• As loading related operations will be performed regardless of the test mode operations being performed, be sure to check that the disc is stopped before setting and removing it.

Even if the <u>\( \text{\text{EJECT}} \)</u> button is pressed while the disc is rotating during continuous playback, continuous recording, etc., the disc will not stop rotating.

Therefore, it will be ejected while rotating.

Be sure to press the <u>\( \beta\) EJECT</u> button after pressing the <u>\( \text{MENU/NO} \)</u> button and the rotation of disc is stopped.

#### 1-1. Recording laser emission mode and operating buttons

- Continuous recording mode (CREC MODE)
- Laser power check mode (LDPWR CHECK)
- Laser power adjustment mode (LDPWR ADJUST)
- Traverse (MO) check (EF MO CHECK)
- Traverse (MO) adjustment (EF MO ADJUST)
- When pressing the REC button.

#### 2. SETTING THE TEST MODE

The following are two methods of entering the test mode.

Procedure 1: While pressing the AMS ▶ knob and button, connect the power plug to an outlet, and release the AMS ▶ knob and button.

When the test mode is set, "[Check]" will be displayed. Turn the  $\boxed{\mathbb{AMS} \blacktriangleright \mathbb{N}}$  knob switches between the following four groups;  $\cdots \longleftarrow$  [Check]  $\longleftrightarrow$  [Adjust]  $\longleftrightarrow$  [Service]  $\longleftrightarrow$  [Develop]  $\longleftrightarrow \cdots$ .

Procedure 2: While pressing the AMS knob, connect the power plug to the outlet and release the AMS knob. When the test mode is set, "TEMP CHECK" will be displayed. By setting the test mode using this method, only the "Check" group of method 1 can be executed.

#### 3. EXITING THE TEST MODE

Press the REPEAT button. The disc is ejected when loaded, and "Standby" display blinks, and the STANDBY state is set.

#### 4. BASIC OPERATIONS OF THE TEST MODE

All operations are performed using the AMS knob, YES button, and MENU/NO button. The functions of these buttons are as follows.

Function name	Function
I◀◀ AMS ▶▶ knob	Changes parameters and modes
YES button	Proceeds onto the next step. Finalizes input.
MENU/NO button	Returns to previous step. Stops operations.

#### 5. SELECTING THE TEST MODE

There are 31 types of test modes as shown below. The groups can be switched by turn the AMS knob. After selecting the group to be used, press the YES button. After setting a certain group, turn the AMS knob switches between these modes. Refer to "Group" in the table for details selected.

All items used for servicing can be treated using group S. So be carefully not to enter other groups by mistake.

Display	No.	Contents	Mark	(	Grou	p (*	)
TEMP CHECK	C01	Temperature compensation offset check		С		S	
LDPWR CHECK	C02	Laser power check		С		S	
EF MO CHECK	C03	Traverse (MO) check		С		S	
EF CD CHECK	C04	Traverse (CD) check		С		S	
FBIAS CHECK	C05	Focus bias check		С		S	
ScurveCHECK	C06	S letter check	(X)	С			
VERIFYMODE	C07	Non-volatile memory check	(X)	С			
DETRK CHECK	C08	Detrack check	(X)	С			
TEMP ADJUST	C09	Temperature compensation offset adjustment			Α	S	
LDPWR ADJUST	C10	Laser power adjustment			A	S	
EF MO ADJUST	C11	Traverse (MO) adjustment			A	S	
EF CD ADJUST	C12	Traverse (CD) adjustment			A	S	
FBIAS ADJUST	C13	Focus bias adjustment			Α	S	
EEP MODE	C14	Non-volatile memory control	(X) (!)				D
Impossible	C15	Command transmission	(X)				D
Impossible	C16	Status display	(X)				D
ERR DP MODE	C17	Error history display, clear				S	
Impossible	C18	Sled check	(X)				D
Impossible	C19	Access check	(X)				D
Impossible	C20	Outermost circumference check	(X)				D
Impossible	C21	Head position check	(X)				D
Impossible	C22	Same functions as CPLAY MODE	(X)				D
Impossible	C23	Same functions as CREC MODE	(X)				D
ADJ CLEAR	C24	Initialization of non-volatile memory of adjustment value			A	S	
AG Set (MO)	C25	Auto gain output level adjustment (MO)			A	S	
AG Set (CD)	C26	Auto gain output level adjustment (CD)			A	S	
Iop Read	C27	IOP data display		С		S	
Iop Write	C28	IOP data write			A	S	
S40 *****	C29	Microprocessing version display		С		S	
CPLAY MODE	C30	Continuous play mode		С	A	S	D
CREC MODE	C31	Continuous recording mode		С	A	S	D

Group (\*)

C: Check A: Adjust S: Service D: Develop

- For details of each adjustment mode, refer to "5. Electrical Adjustments". For details of "ERR DP MODE", refer to "Self-Diagnosis Function" on page 2.
- If a different mode has been selected by mistake, press the MENU/NO button to exit that mode.
- Modes with (X) in the Mark column are not used for servicing and therefore are not described in detail. If these modes are set accidentally, press the MENU/NO button to exit the mode immediately. Be especially careful not to set the modes with (!) as they will overwrite the non-volatile memory and reset it, and as a result, the unit will not operate normally.

#### 5-1. Operating the Continuous Playback Mode

- 1. Entering the continuous playback mode
- (1) Set the disc in the unit. (Whichever recordable discs or discs for playback only are available.)
- (2) Turn the AMS knob and display "CPLAY MODE" (C30).
- (3) Press the YES button to change the display to "CPLAY MID".
- (4) When access completes, the display changes to "C1 =  $\square\square\square\square$ ".

**Note:** The numbers "" displayed show you error rates and ADER.

- 2. Changing the parts to be played back
- (1) Press the YES button during continuous playback to change the display as below.



When pressed another time, the parts to be played back can be moved.

When access completes, the display changes to "C1 = 0000 AD = 000".

**Note:** The numbers "U" displayed show you error rates and ADER.

- 3. Ending the continuous playback mode
- (1) Press the MENU/NO button. The display will change to "CPLAY MODE".
- (2) Press the <u>\(\beta\) EJECT</u> button to remove the disc.

Note: The playback start addresses for IN, MID, and OUT are as follows.

IN 40h cluster MID 300h cluster OUT 700h cluster

#### 5-2. Operating the Continuous Recording Mode (Use only when performing self-recording/palyback check.)

- 1. Entering the continuous recording mode
- (1) Set a recordable disc in the unit.
- (2) Turn the AMS knob and display "CREC MODE".
- (3) Press the YES button to change the display to "CREC MID" (C31)
- (4) When access completes, the display changes to "CREC (DDDD" and REC lights up.

**Note:** The numbers "0" displayed shows you the recording position addresses.

- 2. Changing the parts to be recorded
- (1) When the YES button is pressed during continuous recording, the display changes as below.

"CREC MID" 
$$\rightarrow$$
 "CREC OUT"  $\rightarrow$  "CREC IN"—

When pressed another time, the parts to be recorded can be changed. **REC** goes off.

(2) When access completes, the display changes to "CREC ( and REC lights up.

Note: The numbers "!" displayed shows you the recording position addresses.

- 3. Ending the continuous recording mode
- (1) Press the MENU/NO button. The display changes to "CREC MODE" and REC goes off.
- (2) Press the ☐ EJECT button to remove the disc.

Note 1: The recording start addresses for IN, MID, and OUT are as follows.

IN 40h cluster MID 300h cluster OUT 700h cluster

**Note 2:** The MENU/NO button can be used to stop recording anytime.

**Note 3:** Do not perform continuous recording for long periods of time above 5 minutes.

**Note 4:** During continuous recording, be careful not to apply vibration.

#### 5-3. Non-Volatile Memory Mode (EEP MODE)

This mode reads and writes the contents of the non-volatile memory.

It is not used in servicing. If set accidentally, press the  $\boxed{\text{MENU/NO}}$  button immediately to exit it.

#### 6. FUNCTIONS OF OTHER BUTTONS

Function	Contents	
Sets continuous playback when pressed in the STOP state. When pressed during continuous playback, the tracking turns ON/OFF.		
	Stops continuous playback and continuous recording.	
<b>&gt;&gt;</b>	The sled moves to the outer circumference only when this is pressed.	
<b>←</b>	The sled moves to the inner circumference only when this is pressed.	
SCROLL	Switches between the pit and groove modes when pressed.	
PLAY MODE	Switches the spindle servo mode (CLVS $\longleftrightarrow$ CLV A).	
LEVEL/DISPLAY/CHAR	Switches the displayed contents each time the button is pressed	
EJECT ≙	Ejects the disc	
REPEAT	Exits the test mode	

#### 7. TEST MODE DISPLAYS

Each time the DISPLAY/CHAR button is pressed, the display changes in the following order.

1.	MOU	c dispiay				
Dis	splays	"TEMP	ADJUST",	"CPLA	YMODE",	etc.

2.	Error	rate	displ	lay
----	-------	------	-------	-----

1 Mode dienlay

Displays	the error	rate in	the f	ollowing	wav.

 $C1 = \square \square \square \square \square AD = \square \square$ 

C1 = Indicates the C1 error.

AD = Indicates ADER.

#### 3. Address display

The address is displayed as follows. (MO: recordable disc, CD: playback only disc)

Pressing the SCROLL/CLOCK SET button switches between the group display and bit display.

 $h = \square \square \square \square s = \square \square \square \square$  (MO pit and CD)

 $h = \square\square\square\square$   $a = \square\square\square\square$  (MO groove)

h = Indicates the header address.

s = Indicates the SUBQ address.

a = Indicates the ADIP address.

Note: "-" is displayed when servo is not imposed.

4. Auto gain display (Not used in servicing)

The auto gain is displayed as follows.

 $AG = \square\square/\square\square[\square\square]$ 

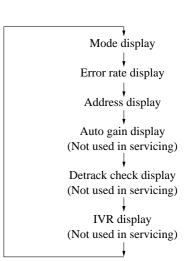
5. Detrack check display (Not used in servicing)

The detrack is displayed as follows.

 $ADR = \Box\Box\Box\Box\Box\Box\Box$ 

6. IVR display (Not used in servicing)

The IVR is displayed as follows.



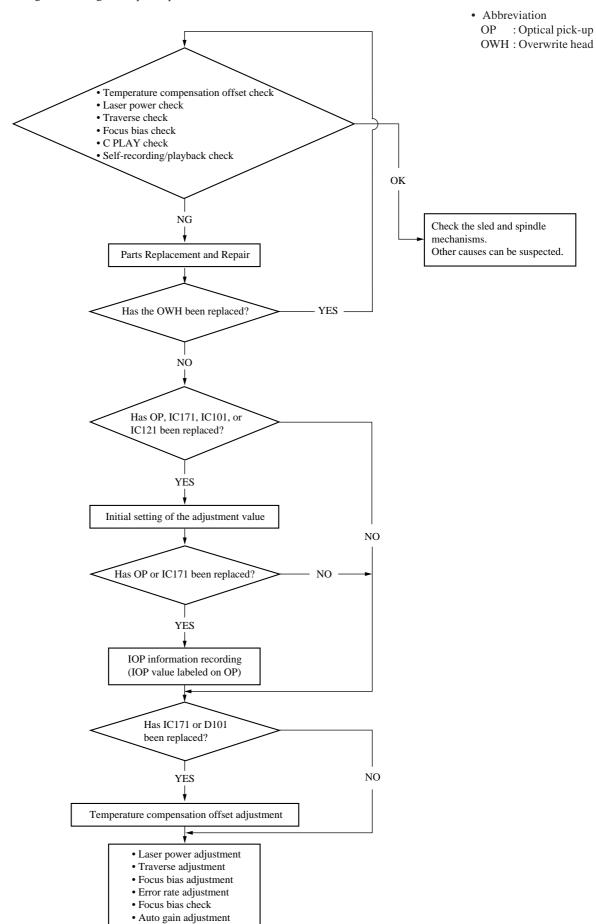
#### **MEANINGS OF OTHER DISPLAYS**

Diaplay	Contents				
Display	When Lit	When Off			
<b></b>	During continuous playback (CLV: ON)	STOP (CLV: OFF)			
ш	Tracking servo OFF	Tracking servo ON			
REC	Recording mode ON	Recording mode OFF			
SYNC	CLV low speed mode	CLV normal mode			
L.SYNC	ABCD adjustment completed				
OVER	Tracking offset cancel ON	Tracking offset cancel OFF			
В	Tracking auto gain OK				
A-	Focus auto gain OK				
TRACK	Pit	Groove			
DISC	High reflection	Low reflection			
SLEEP	CLV-S	CLV-A			
MONO	CLV LOCK	CLV UNLOCK			

# SECTION 5 ELECTRICAL ADJUSTMENTS

#### 1. PARTS REPLACEMENT AND ADJUSTMENT

Check and adjust the MDM and MBU as follows.
 The procedure changes according to the part replaced

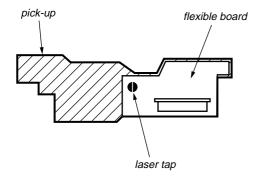


### 2. PRECAUTIONS FOR CHECKING LASER DIODE EMISSION

To check the emission of the laser diode during adjustments, never view directly from the top as this may lose your eye-sight.

# 3. PRECAUTIONS FOR USE OF OPTICAL PICK-UP (KMS-260A)

As the laser diode in the optical pick-up is easily damaged by static electricity, solder the laser tap of the flexible board when using it. Before disconnecting the connector, desolder first. Before connecting the connector, be careful not to remove the solder. Also take adequate measures to prevent damage by static electricity. Handle the flexible board with care as it breaks easily.



Optical pick-up flexible board

#### 4. PRECAUTIONS FOR ADJUSTMENTS

1. When replacing the following parts, perform the adjustments and checks with **O** in the order shown in the following table.

	Optical		В	D Board	
	Pick-up	IC171	D101	IC101, IC121	IC192
1.Initial setting of adjustment value	0	0	×	0	×
2. Recording of IOP information (Value written in the pick-up)	0	0	×	×	×
3. Temperature compensation offset adjustment	×	0	0	×	×
4. Laser power adjustment	0	0	×	0	0
5. Traverse adjustment	0	0	×	0	×
6. Focus bias adjustment	0	0	×	0	×
7. Error rate check	0	0	×	0	×
8. Auto gain output level adjustment	0	0	×	0	×

- Set the test mode when performing adjustments.
   After completing the adjustments, exit the test mode.
   Perform the adjustments and checks in "group S" of the test mode.
- 3. Perform the adjustments to be needed in the order shown.

- 4. Use the following tools and measuring devices.
  - Check Disc (MD) TDYS-1 (Parts No. 4-963-646-01)
  - TEST DISK (MDW-74/AU-1) (Parts No. 8-892-341-41)
  - Laser power meter LPM-8001 (Parts No. J-2501-046-A) or MD Laser power meter 8010S (Parts No. J-2501-145-A)
  - Oscilloscope (Measure after performing CAL of prove)
  - · Digital voltmeter
  - Thermometer
  - Jig for checking BD board waveform (Parts No.: J-2501-149-A)
- When observing several signals on the oscilloscope, etc., make sure that VC and ground do not connect inside the oscilloscope.

(VC and ground will become short-circuited)

- Using the above jig enables the waveform to be checked without the need to solder.
  - (Refer to Servicing Notes on page 6)
- As the disc used will affect the adjustment results, make sure that no dusts nor fingerprints are attached to it.

#### Laser power meter

When performing laser power checks and adjustment (electrical adjustment), use of the new MD laser power meter 8010S (J-2501-145-A) instead of the conventional laser power meter is convenient.

It sharply reduces the time and trouble to set the laser power meter sensor onto the objective lens of the pick-up.

#### 5. CREATING CONTINUOUSLY-RECORDED DISC

- \* This disc is used in focus bias adjustment and error rate check. The following describes how to create a continuous recording disc.
- 1. Insert a disc (blank disc) commercially available.
- Turn the AMS ► knob and display "CREC MODE". (C31)
- 3. Press the YES button again to display "CREC MID". Display "CREC (0300)" and start to recording.
- 4. Complete recording within 5 minutes.
- 5. Press the MENU/NO button and stop recording.
- 6. Press the <u>\( \beta\) EJECT</u> button and remove the disc.

The above has been how to create a continuous recorded data for the focus bias adjustment and error rate check.

#### Note:

· Be careful not to apply vibration during continuous-recording.

#### 6. CHECK PRIOR TO REPAIRS

These checks are performed before replacing parts according to "approximate specifications" to determine the faulty locations. For details, refer to "Checks Prior to Parts Replacement and Adjustments" (See page 8).

#### 6-1. Temperature Compensation Offset Check

When performing adjustments, set the internal temperature and room temperature of 22  $^{\circ}\text{C}$  to 28  $^{\circ}\text{C}.$ 

**Checking Procedure:** 

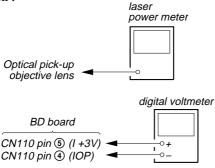
- Turn the AMS ► knob to display "TEMP CHECK" (C01).
- 2. Press the YES button.
- 3. "T=@@(##) [OK" should be displayed. If "T=@@ (##) [NG" is displayed, it means that the results are bad.

  (@@ indicates the current value set, and ## indicates the value written in the non-volatile memory)

#### 6-2. Laser Power Check

Before checking, check the IOP value of the optical pick-up. (Refer to 5-8. Recording and Displaying IOP Information)

#### **Connection:**



#### **Checking Procedure:**

- 1. Set the laser power meter on the objective lens of the optical pick-up. (When it cannot be set properly, press the button or ▶ button to move the optical pick-up)

  Connect the digital volt meter to CN110 pin ⑤ (I+3V) and CN110 pin ④ (IOP).
- 2. Then, turn the AMS ▶ knob and display "LDPWR CHECK" (C02).
- Press the YES button once and display "LD 0.9 mW \$ 00".
   Check that the reading of the laser power meter become 0.84 to 0.92 mW.
- 4. Press the YES button once more and display "LD 7.0 mW \$ 00". Check that the reading the laser power meter and digital volt meter satisfy the specified value.

#### **Specification:**

Laser power meter reading:  $7.0 \pm 0.2 \text{ mW}$ 

Digital voltmeter reading : Optical pick-up displayed value  $\pm 10\%$ 

(Optical pick-up label)



IOP=82.5 mA in this case

 $IOP(mA) = Digital\ voltmeter\ reading\ (mV)/1\ (\Omega)$ 

5. Press the MENU/NO button and display "LDPWR CHECK" and stop the laser emission.

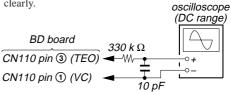
(The MENU/NO button is effective at all times to stop the laser emission)

Note 1: After step 4, each time the YES button is pressed, the display will be switched between "LD 0.7 mW \$ UU", "LD 6.2 mW \$ UU", and "LD Wp ホセイ \$ UU". Nothing needs to be performed here.

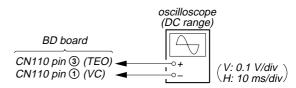
#### 6-3. Traverse Check

**Note 1:** Data will be erased during MO reading if a recorded disc is used in this adjustment.

Note 2: If the traverse waveform is not clear, connect the oscilloscope as shown in the following figure so that it can be seen more clearly



#### Connection:



#### **Checking Procedure:**

- Connect an oscilloscope to CN110 pin ③ (TEO) and CN110 pin ① (VC) of the BD board.
- 2. Load a disc (any available on the market). (Refer to Note 1)
- 3. Press the button and move the optical pick-up outside the pit.
- Turn the ► knob and display "EF MO CHECK" (C03).
- Press the YES button and display "EFB = 00 MO-R".
   (Laser power READ power/Focus servo ON/tracking servo OFF/spindle (S) servo ON)

(Read power traverse checking)

(Traverse Waveform)



Specified value: Below 10% offset value

Offset value (%) = 
$$\frac{IA - BI}{2(A + B)} \times 100$$

- 7. Press the YES button and display "EFB = 00 MO-W".
- 8. Observe the waveform of the oscilloscope, and check that the specified value is satisfied. Do not turn the AMS knob.

(Write power traverse checking)

(Traverse Waveform)



Specified value : Below 10% offset value

Offset value (%) =  $\frac{IA - BI}{2(A + B)} \times 100$ 

- Press the YES button display "EFB = 00 MO-P".
   Then, the optical pick-up moves to the pit area automatically and servo is imposed.
- 10. Observe the waveform of the oscilloscope, and check that the specified value is satisfied. Do not turn the ★★ AMS ★★ knob.

(Traverse Waveform)



Specified value : Below 10% offset value

Offset value (%) = 
$$\frac{IA - BI}{2(A + B)} \times 100$$

- 11. Press the YES button display "EF MO CHECK" The disc stops rotating automatically.
- 12. Press the <u>\(\Delta\) EJECT</u> button and remove the disc.
- 13. Load the check disc (MD) TDYS-1.
- 14. Turn the ★ AMS ★ knob and display "EF CD CHECK" (C04).
- 15. Press the YES button and display "EFB = 00 CD". Servo is imposed automatically.
- 16. Observe the waveform of the oscilloscope, and check that the specified value is satisfied. Do not turn the ★ AMS ★ knob.

(Traverse Waveform)



Specified value : Below 10% offset value

Offset value (%) = 
$$\frac{IA - BI}{2(A + B)} \times 100$$

- 17. Press the YES button and display "EF CD CHECK".
- 18. Press the <u>EJECT</u> button and take out the check disc.

#### 6-4. Focus Bias Check

Change the focus bias and check the focus tolerance amount. Checking Procedure :

- 1. Load the test disk (MDW-74/AU-1).
- Turn the AMS ► knob and display "CPLAY MODE" (C30).
- 3. Press the YES button twice and display "CPLAY MID".
- 4. Press the MENU/NO button when "C = 0000 AD = 00" is displayed.
- Turn the AMS knob and display "FBIAS CHECK" (C05).
- 6. Press the YES button and display "UUUU/UU c = UU". The first four digits indicate the C1 error rate, the two digits after [/] indicate ADER, and the 2 digits after [c =] indicate the focus bias value.
  - Check that the C1 error is below 50 and ADER is below 2.
- 7. Press the YES button and display "UUUU/UU b = UU". Check that the C1 error is about 200 and ADER is below 2.
- 8. Press the YES button and display "UUUU/UU a = UU". Check that the C1 error is about 200 and ADER is below 2.
- 9. Press the MENU/NO button, next press the ☐ EJECT button and take out the test disc.

#### 6-5. C PLAY Checking

#### **MO Error Rate Check**

#### **Checking Procedure:**

- 1. Load the test disk (MDW-74/AU-1).
- Turn the AMS ► knob and display "CPLAY MODE" (C30).
- 3. Press the YES button and display "CPLAY MID".
- 4. The display changes to "C = UUUU AD = UU".
- 5. If the C1 error rate is below 80, check that ADER is below 2.

#### **CD Error Rate Check**

#### **Checking Procedure:**

- 1. Load the check disc (MD) TDYS-1.
- Turn the AMS ▶ knob and display "CPLAY MODE"
- 3. Press the YES button twice and display "CPLAY MID".
- 4. The display changes to "C = 00000 AD = 000".
- 5. Check that the C1 error rate is below 50.

#### 6-6. Self-Recording/playback Check

Prepare a continuous recording disc using the unit to be repaired and check the error rate.

#### **Checking Procedure:**

- 1. Insert a recordable disc (blank disc) into the unit.
- 3. Press the YES button to display the "CREC MID".
- 4. When recording starts, " **REC** " is displayed, this becomes "CREC @ @ @ " (@ @ @ @ is the address), and recording starts.
- About 1 minute later, press the MENU/NO button to stop continuous recording.
- 7. Press the YES button to display "CPLAY MID".
- 8. "C = 00000 AD = 000" will be displayed.
- Check that the C1 error becomes below 80 and the AD error below 2
- 10. Press the MENU/NO button to stop playback, and press the <u>EJECT</u> button and take out the disc.

#### 7. INITIAL SETTING OF ADJUSTMENT VALUE

#### Note:

Mode which sets the adjustment results recorded in the non-volatile memory to the initial setting value. However the results of the temperature compensation offset adjustment will not change to the initial setting value.

If initial setting is performed, perform all adjustments again excluding the temperature compensation offset adjustment.

For details of the initial setting, refer to "4. Precautions on Adjustments" and execute the initial setting before the adjustment as required.

#### **Setting Procedure:**

- 1. Turn the AMS | knob to display "ADJ CLEAR (C24)".
- Press the YES button. "Complete!" will be displayed momentarily and initial setting will be executed, after which "ADJ CLEAR" will be displayed.

### 8. RECORDING AND DISPLAYING THE IOP INFORMATION

The IOP data can be recorded in the non-volatile memory. The IOP value on the label of the optical pickup and the IOP value after the adjustment will be recorded. Recording these data eliminates the need to read the label on the optical pick-up.

#### **Recording Procedure:**

- Turn the AMS ► knob to display "Iop Write" (C28), and press the YES button.
- 2. The display becomes Ref=@@@.@ (@ is an arbitrary number) and the numbers which can be changed will blink.
- 3. Input the IOP value written on the optical pick-up.

  To select the number: Turn the 

  AMS → knob.

  To select the digit: Press the AMS → knob
- 4. When the YES button is pressed, the display becomes "Measu=@@@.@" (@ is an arbitrary number).
- 5. As the adjustment results are recorded for the 6 value. Leave it as it is and press the YES button.
- "Complete!" will be displayed momentarily. The value will be recorded in the non-volatile memory and the display will become "Iop Write".

#### **Display Procedure:**

- 1. Turn the ► AMS ► knob to display "Iop Read" (C27).
- "@@.@/##.#" is displayed and the recorded contents are displayed.
  - @@.@ indicates the IOP value labeled on the pick-up. ##.# indicates the IOP value after adjustment
- 3. To end, press the ★ AMS ★ button or MENU/NO button to display "Iop Read".

### 9. TEMPERATURE COMPENSATION OFFSET ADJUSTMENT

Save the temperature data at that time in the non-volatile memory as  $25\,^{\circ}\mathrm{C}$  reference data.

#### Note:

- 1. Usually, do not perform this adjustment.
- Perform this adjustment in an ambient temperature of 22 °C to 28 °C.
   Perform it immediately after the power is turned on when the internal temperature of the unit is the same as the ambient temperature of 22 °C to 28 °C.
- 3. When D101 has been replaced, perform this adjustment after the temperature of this part has become the ambient temperature.

#### **Adjusting Procedure:**

- Turn the I AMS ► knob and display "TEMP ADJUST" (C09).
- 2. Press the YES button and select the "TEMP ADJUST" mode.
- "TEMP = ||| [OK" and the current temperature data will be displayed.
- 4. To save the data, press the YES button.
  When not saving the data, press the MENU/NO button.
- 5. When the YES button is pressed, "TEMP = 00 SAVE" will be displayed and turned back to "TEMP ADJUST" display then. When the MENU/NO button is pressed, "TEMP ADJUST" will be displayed immediately.

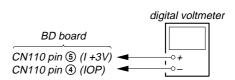
#### **Specified Value:**

The "TEMP =  $\bigcirc$ " should be within "E0 - EF", "F0 - FF", "00 - 0F", "10 - 1F" and "20 - 2F".

#### 10. LASER POWER ADJUSTMENT

Check the IOP value of the optical pick-up before adjustments. (Refer to 8. Recording and Displaying IOP Information)





#### **Adjusting Procedure:**

- Set the laser power meter on the objective lens of the optical pick-up. (When it cannot be set properly, press the button or button to move the optical pick-up.)
   Connect the digital volt meter to CN110 pin (1+3V) and CN110 pin (4) (IOP).
- - (Laser power : For adjustment)
- 3. Press the YES button once and display "LD 0.9 mW \$ 999".
- 4. Turn the ◀◀ AMS ▶▶ knob so that the reading of the laser power meter becomes 0.85 to 0.91 mW. Press the ▼ES button after setting the range knob of the laser power meter, and save the adjustment results. ("LD SAVE \$ □□" will be displayed for a moment.)
- 5. Then "LD 7.0 mW \$ \till" will be displayed.
- 6. Turn the ★★ AMS ★★ knob so that the reading of the laser power meter becomes 6.9 to 7.1 mW, press the ★★ button and save it.

**Note:** Do not perform the emission with 7.0 mW more than 15 seconds continuously.

- 7. Then, turn the ► AMS ► knob and display "LDPWR CHECK" (C02).
- 8. Press the YES button once and display "LD 0.9 mW \$ \( \)\". Check that the reading of the laser power meter become 0.85 to 0.91 mW.
- 9. Press the YES button once more and display "LD 7.0 mW \$ \tilde{\text{"}}. Check that the reading the laser power meter and digital volt meter satisfy the specified value.

  Note down the digital voltmeter reading value.

Specification:

Laser power meter reading:  $7.0 \pm 0.2 \text{ mW}$ 

Digital voltmeter reading: Optical pick-up displayed value

 $\pm 10\%$ 

(Optical pick-up label)



IOP=82.5 mA in this case

 $IOP(mA) = Digital\ voltmeter\ reading\ (mV)/1\ (\Omega)$ 

10. Press the MENU/NO button and display "LDPWR CHECK" and stop the laser emission.

(The MENU/NO) button is effective at all times to stop the laser emission.)

- 11. Turn the ▲ AMS ▶ knob to display "Iop Write" (C28).
- 12. Press the YES button. When the display becomes Ref=@@@.@ (@ is an arbitrary number), press the YES button to display "Measu=@@@.@" (@ is an arbitrary number).
- 13. The numbers which can be changed will blink. Input the Iop value noted down at step 9.

To select the number: Turn the AMS knob. To select the digit: Press the AMS knob.

14. When the YES button is pressed, "Complete!" will be displayed momentarily. The value will be recorded in the non-volatile memory and the display will become "Iop Write".

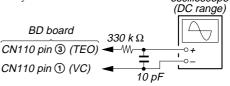
Note 1: After step 4, each time the <u>YES</u> button is pressed, the display will be switched between "LD 0.7 mW \$ !!!!", "LD 6.2 mW \$ !!!!", and "LD Wp ホセイ \$ !!!!". Nothing needs to be performed here.

#### 11. TRAVERSE ADJUSTMENT

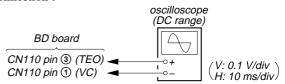
Note 1:Data will be erased during MO reading if a recorded disc is used in this adjustment.

Note 2: If the traverse waveform is not clear, connect the oscilloscope as shown in the following figure so that it can be seen more clearly.

oscilloscope



#### **Connection:**



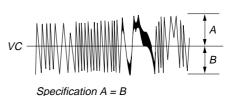
#### **Adjusting Procedure:**

- 1. Connect an oscilloscope to CN110 pin ③ (TEO) and CN110 pin ① (VC) of the BD board.
- 2. Load a disc (any available on the market). (Refer to Note 1)
- 3. Press the button and move the optical pick-up outside the pit.
- Turn the AMS ► knob and display "EF MO ADJUST" (C10).
- Press the YES button and display "EFB = || MO-R".
   (Laser power READ power/Focus servo ON/tracking servo OFF/spindle (S) servo ON)
- 6. Turn the AMS knob so that the waveform of the oscilloscope becomes the specified value.

(When the [♣♠ AMS ▶▶] knob is turned, the ∰ of "EFB= ⊕⊕" changes and the waveform changes.) In this adjustment, waveform varies at intervals of approx. 2%. Adjust the waveform so that the specified value is satisfied as much as possible.

(Read power traverse adjustment)

(Traverse Waveform)



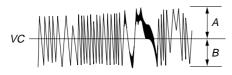
7. Press the YES button and save the result of adjustment to the non-volatile memory ("EFB = || SAV" will be displayed for a moment. Then "EFB = || MO-W" will be displayed).

8. Turn the AMS knob so that the waveform of the oscilloscope becomes the specified value.

(When the AMS I knob is turned, the of "EFB-" changes and the waveform changes.) In this adjustment, waveform varies at intervals of approx. 2%. Adjust the waveform so that the specified value is satisfied as much as possible.

(Write power traverse adjustment)

(Traverse Waveform)



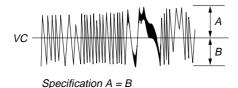
Specification A = B

- 9. Press the YES button, and save the adjustment results in the non-volatile memory. ("EFB = || SAV" will be displayed for a moment.)
- 10. "EFB = (iii) MO-P". will be displayed. The optical pick-up moves to the pit area automatically and servo is imposed.
- 11. Turn the AMS knob until the waveform of the oscilloscope moves closer to the specified value.

  In this adjustment, waveform varies at intervals of approx. 2%. Adjust the waveform so that the specified value is satisfied as

(Traverse Waveform)

much as possible.



- 12. Press the YES button, and save the adjustment results in the non-volatile memory. ("EFB = 3 SAV" will be displayed for a moment.)
  - Next "EF MO ADJUST" is displayed. The disc stops rotating automatically.
- 13. Press the ☐ EJECT button and take out the disc.
- 14. Load the check disc (MD) TDYS-1.

(Traverse Waveform)

- 15. Turn the ★ AMS ★ knob and display "EF CD ADJUST" (C12).
- 16. Press the YES button and display "EFB = 00 CD". Servo is imposed automatically.
- 17. Turn the AMS knob so that the waveform of the oscilloscope moves closer to the specified value.

  In this adjustment, waveform varies at intervals of approx. 2%.

Adjust the waveform so that the specified value is satisfied as much as possible.

VC ABOUT ABO

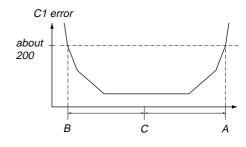
Specification A = B

- 18. Press the YES button, display "EFB = \$\overline{100}\$ SAV" for a moment and save the adjustment results in the non-volatile memory.
  - Next "EF CD ADJUST" will be displayed.
- 19. Press the <u>\(\beta\) EJECT</u> button and take out the disc.

#### 12. FOCUS BIAS ADJUSTMENT

#### **Adjusting Procedure:**

- Load the continuously-recorded disc. (Refer to "5. CREAT-ING CONTINUOUSLY-RECORDED DISC")
- Turn the AMS ► knob and display "CPLAY MODE" (C29).
- 3. Press the YES button and display "CPLAY MID".
- 4. Press the MENU/NO button when "C1 = UUUU AD = UU" is displayed.
- Turn the AMS ► knob and display "FBIAS ADJUST" (C13).
- 6. Press the YES button and display "UUUU/UU a = UU". The first four digits indicate the C1 error rate, the two digits after [/] indicate ADER, and the 2 digits after [a =] indicate the focus bias value.
- Turn the AMS knob in the clockwise direction and find the focus bias value at which the C1 error rate becomes about 200 (Refer to Note 2).
- 8. Press the YES button and display "UUUU/UU b = UU".
- Turn the AMS I knob in the counterclockwise direction and find the focus bias value at which the C1 error rate becomes about 200.
- 10. Press the YES button and display "0000/00 c = 00".
- 11. Check that the C1 error rate is below 50 and ADER is 00. Then press the YES button.
- 12. If the "(UU)" in "UU UU UU (UU)" is above 20, press the YES button.
  - If below 20, press the MENU/NO button and repeat the adjustment from step 2.
- 13. Press the <u>\(\text{\rightar}\) EJECT</u> button and take out the disc.
- Note 1: The relation between the C1 error and focus bias is as shown in the following figure. Find points A and B in the following figure using the above adjustment. The focal point position C is automatically calculated from points A and B.
- **Note 2:** As the C1 error rate changes, perform the adjustment using the average vale.



Focus bias value (F. BIAS)

#### 13. ERROR RATE CHECK 13-1. CD Error Rate Check

#### **Checking Procedure:**

- 1. Load the check disc (MD) TDYS-1.
- Turn the AMS ► knob and display "CPLAY MODE" (C30).
- 3. Press the YES button twice and display "CPLAY MID".
- 4. The display changes to "C1 = 00000 AD = 0000".
- 5. Check that the C1 error rate is below 20.

#### 13-2. MO Error Rate Check

#### **Checking Procedure:**

- 1. Load the test disc (MDW-74/AU-1).
- Turn the AMS ► knob and display "CPLAY MODE" (C30).
- 3. Press the YES button and display "CPLAY MID".
- 4. The display changes to "C1 = 00000 AD = 000".
- 5. If the C1 error rate is below 50, check that ADER is 00.

#### 14. FOCUS BIAS CHECK

Change the focus bias and check the focus tolerance amount. Checking Procedure :

- Load the continuously-recorded disc. (Refer to "5. CREAT-ING CONTINUOUSLY-RECORDED DISC")
- Turn the AMS ► knob and display "CPLAY MODE" (C30).
- 3. Press the YES button twice and display "CPLAY MID".
- 4. Press the MENU/NO button when "C1 = 0000 AD = 00" is displayed.
- Turn the AMS ► knob and display "FBIAS CHECK" (C05).
- 6. Press the YES button and display "DDD c = DD". The first four digits indicate the C1 error rate, the two digits after [/] indicate ADER, and the 2 digits after [c =] indicate the focus bias value.
  - Check that the C1 error is below 50 and ADER is below 2.
- 7. Press the YES button and display "UUUU/UU b = UU". Check that the C1 error is about 200 and ADER is below 2.
- 8. Press the YES button and display "UUUU/UU a = UU". Check that the C1 error is about 200 and ADER is below 2
- 9. Press the MENU/NO button, next press the <u>EJECT</u> button and take out the disc.

**Note 1:** If the C1 error and ADER are above other than the specified value at points a (step 8. in the above) or b (step 7. in the above), the focus bias adjustment may not have been carried out properly. Adjust perform the beginning again.

### 15. AUTO GAIN CONTROL OUTPUT LEVEL ADJUSTMENT

Be sure to perform this adjustment when the pickup is replaced. If the adjustment results becomes "Adjust NG!", the pickup may be faulty or the servo system circuits may be abnormal.

### 15-1. CD Auto Gain Control Output Level Adjustment Adjusting Procedure:

- 1. Insert the check disc (MD) TDYS-1.
- 2. Turn the AMS ▶ knob to display "AG Set (CD)" (C26).
- When the YES button is pressed, the adjustment will be performed automatically.
   "Complete!!" will then be displayed momentarily when the
  - "Complete!!" will then be displayed momentarily when the value is recorded in the non-volatile memory, after which the display changes to "AG Set (CD)".
- 4. Press the ☐ EJECT button and take out the check disc.

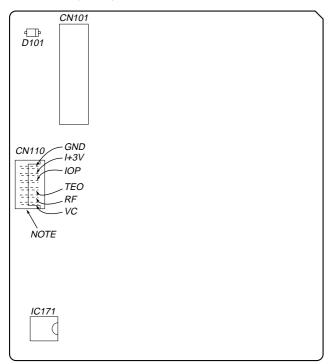
#### 15-2. MO Auto Gain Control Output Level Adjustment

#### **Adjusting Procedure:**

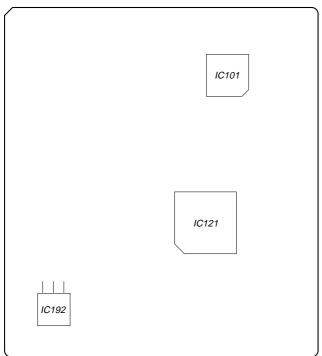
- 1. Insert the test disc (MDW-74/AU-1) for recording.
- 2. Turn the AMS knob to display "AG Set (MO)" (C25).
- When the YES button is pressed, the adjustment will be performed automatically.
  - "Complete!!" will then be displayed momentarily when the value is recorded in the non-volatile memory, after which the display changes to "AG Set (MO)".
- 4. Press the ☐ EJECT button and take out the test disc.

#### **Adjustment Location:**

#### - BD BOARD (Side A) -



#### - BD BOARD (Side B) -



Note: It is useful to use the jig. for checking the waveform. (Refer to Servicing Notes on page 6)

#### SECTION 6 DIAGRAMS

#### 6-1. IC PIN FUNCTION DESCRIPTION

#### • BD BOARD IC101 CXA2523AR (RF AMP, FOCUS/TRACKING ERROR AMP)

Pin No.	Pin Name	I/O	Description
1	I	I	I-V converted RF signal I input from the optical pick-up block detector
2	J	I	I-V converted RF signal J input from the optical pick-up block detector
3	VC	О	Middle point voltage (+1.65V) generation output terminal
4 to 9	A to F	I	Signal input from the optical pick-up detector
10	PD	I	Light amount monitor input from the optical pick-up block laser diode
11	APC	О	Laser amplifier output terminal to the automatic power control circuit
12	APCREF	I	Reference voltage input terminal for setting laser power
13	GND		Ground terminal
14	TEMPI	I	Connected to the temperature sensor
15	TEMPR	О	Output terminal for a temperature sensor reference voltage
16	SWDT	I	Writing serial data input from the CXD2654R (IC121)
17	SCLK	I	Serial data transfer clock signal input from the CXD2654R (IC121)
18	XLAT	I	Serial data latch pulse signal input from the CXD2654R (IC121)
19	XSTBY	I	Standby signal input terminal "L": standby (fixed at "H" in this set)
20	F0CNT	I	Center frequency control voltage input terminal of internal circuit (BPF22, BPF3T, EQ) input from the CXD2654R (IC121)
21	VREF	О	Reference voltage output terminal Not used (open)
22	EQADJ	I	Center frequency setting terminal for the internal circuit (EQ)
23	3TADJ	I	Center frequency setting terminal for the internal circuit (BPF3T)
24	VCC	_	Power supply terminal (+3.3V)
25	WBLADJ	I	Center frequency setting terminal for the internal circuit (BPF22)
26	TE	О	Tracking error signal output to the CXD2654R (IC121)
27	CSLED	I	Connected to the external capacitor for low-pass filter of the sled error signal
28	SE	О	Sled error signal output to the CXD2654R (IC121)
29	ADFM	О	FM signal output of the ADIP
30	ADIN	I	Receives a ADIP FM signal in AC coupling
31	ADAGC	I	Connected to the external capacitor for ADIP AGC
32	ADFG	O	ADIP duplex signal (22.05 kHz ± 1 kHz) output to the CXD2654R (IC121)
33	AUX	О	Auxiliary signal (I <sub>3</sub> signal/temperature signal) output to the CXD2654R (IC121)
34	FE	О	Focus error signal output to the CXD2654R (IC121)
35	ABCD	О	Light amount signal (ABCD) output to the CXD2654R (IC121)
36	BOTM	О	Light amount signal (RF/ABCD) bottom hold output to the CXD2654R (IC121)
37	PEAK	О	Light amount signal (RF/ABCD) peak hold output to the CXD2654R (IC121)
38	RF	О	Playback EFM RF signal output to the CXD2654R (IC121)
39	RFAGC	I	Connected to the external capacitor for RF auto gain control circuit
40	AGCI	I	Receives a RF signal in AC coupling
41	COMPO	О	User comparator output terminal Not used (open)
42	COMPP	I	User comparator input terminal Not used (fixed at "L")
43	ADDC	I	Connected to the external capacitor for cutting the low band of the ADIP amplifier
44	OPO	О	User operational amplifier output terminal Not used (open)
45	OPN	I	User operational amplifier inversion input terminal Not used (fixed at "L")
46	RFO	О	RF signal output terminal
47	MORFI	I	Receives a MO RF signal in AC coupling
48	MORFO	O	MO RF signal output terminal

# • BD BOARD IC121 CXD2654R (DIGITAL SIGNAL PROCESSOR, DIGITAL SERVO PROCESSOR, EFM/ACIRC ENCODER/DECODER, SHOCK PROOF MEMORY CONTROLLER, ATRAC ENCODER/DECODER)

Pin No.	Pin Name	I/O	Description
1	MNT0 (FOK)	О	Focus OK signal output to the system controller (IC501) "H" is output when focus is on ("L": NG)
2	MNT1 (SHOCK)	О	Track jump detection signal output to the system controller (IC501)
3	MNT2 (XBUSY)	О	Busy monitor signal output to the system controller (IC501)
4	MNT3 (SLOCK)	О	Spindle servo lock status monitor signal output to the system controller (IC501)
5	SWDT	I	Writing serial data signal input from the system controller (IC501)
6	SCLK	I(S)	Serial data transfer clock signal input from the system controller (IC501)
7	XLAT	I(S)	Serial data latch pulse signal input from the system controller (IC501)
8	SRDT	O(3)	Reading serial data signal output to the system controller (IC501)
9	SENS	O (3)	Internal status (SENSE) output to the system controller (IC501)
10	XRST	I(S)	Reset signal input from the system controller (IC501) "L": reset
11	SQSY	О	Subcode Q sync (SCOR) output to the system controller (IC501) "L" is output every 13.3 msec Almost all, "H" is output
12	DQSY	О	Digital In U-bit CD format subcode Q sync (SCOR) output to the system controller (IC501) "L" is output every 13.3 msec Almost all, "H" is output
13	RECP	I	Laser power selection signal input from the system controller (IC501) "L": playback mode, "H": recording mode
14	XINT	O	Interrupt status output to the system controller (IC501)
15	TX	Ι	Recording data output enable signal input from the system controller (IC501) Writing data transmission timing input (Also serves as the magnetic head on/off output)
16	OSCI	I	System clock signal (512Fs=22.5792 MHz) input terminal
17	OSCO	О	System clock signal (512Fs=22.5792 MHz) output terminal Not used (open)
18	XTSL	I	Input terminal for the system clock frequency setting "L": 45.1584 MHz, "H": 22.5792 MHz (fixed at "H" in this set)
19	DIN0	I	Digital audio signal input terminal when recording mode (for digital optical input) Not used
20	DIN1	I	Digital audio signal input terminal when recording mode (for digital optical input)
21	DOUT	О	Digital audio signal output terminal when playback mode (for digital optical output) Not used
22	DATAI	I	Serial data input terminal Not used (fixed at "L")
23	LRCKI	I	L/R sampling clock signal (44.1 kHz) input terminal Not used (fixed at "L")
24	XBCKI	I	Bit clock signal (2.8224 MHz) input terminal Not used (fixed at "L")
25	ADDT	I	Recording data input from the A/D, D/A converter (IC301)
26	DADT	О	Playback data output to the A/D, D/A converter (IC301)
27	LRCK	О	L/R sampling clock signal (44.1 kHz) output to the A/D, D/A converter (IC301)
28	XBCK	О	Bit clock signal (2.8224 MHz) output to the A/D, D/A converter (IC301)
29	FS256	0	Clock signal (11.2896 MHz) output terminal Not used (open)
30	DVDD		Power supply terminal (+3.3V) (digital system)
31 to 34	A03 to A00	О	Address signal output to the D-RAM (IC124)
35	A10	О	Address signal output to the external D-RAM Not used (open)
36 to 40	A04 to A08	О	Address signal output to the D-RAM (IC124)
41	A11	О	Address signal output to the external D-RAM Not used (open)
42	DVSS		Ground terminal (digital system)
43	XOE	О	Output enable signal output to the D-RAM (IC124) "L" active
44	XCAS	О	Column address strobe signal output to the D-RAM (IC124) "L" active
l			

<sup>\*</sup> I (S) stands for schmitt input, I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

Pin No.	Pin Name	I/O	Description
45	A09	О	Address signal output to the D-RAM (IC124)
46	XRAS	О	Row address strobe signal output to the D-RAM (IC124) "L" active
47	XWE	О	Write enable signal output to the D-RAM (IC124) "L" active
48	D1	I/O	
49	D0	I/O	The man data has with the D DAM (IC124)
50	D2	I/O	Two-way data bus with the D-RAM (IC124)
51	D3	I/O	
52	MVCI	I(S)	Digital in PLL oscillation input from the external VCO Not used (fixed at "L")
53	ASYO	О	Playback EFM full-swing output terminal
54	ASYI	I(A)	Playback EFM asymmetry comparator voltage input terminal
55	AVDD	_	Power supply terminal (+3.3V) (analog system)
56	BIAS	I(A)	Playback EFM asymmetry circuit constant current input terminal
57	RFI	I(A)	Playback EFM RF signal input from the CXA2523AR (IC101)
58	AVSS	_	Ground terminal (analog system)
59	PCO	O (3)	Phase comparison output for master clock of the recording/playback EFM master PLL
60	FILI	I(A)	Filter input for master clock of the recording/playback master PLL
61	FILO	O (A)	Filter output for master clock of the recording/playback master PLL
62	CLTV	I(A)	Internal VCO control voltage input of the recording/playback master PLL
63	PEAK	I(A)	Light amount signal (RF/ABCD) peak hold input from the CXA2523AR (IC101)
64	BOTM	I(A)	Light amount signal (RF/ABCD) bottom hold input from the CXA2523AR (IC101)
65	ABCD	I(A)	Light amount signal (ABCD) input from the CXA2523AR (IC101)
66	FE	I(A)	Focus error signal input from the CXA2523AR (IC101)
67	AUX1	I(A)	Auxiliary signal (I <sub>3</sub> signal/temperature signal) input from the CXA2523AR (IC101)
68	VC	I(A)	Middle point voltage (+1.65V) input from the CXA2523AR (IC101)
69	ADIO	O (A)	Monitor output of the A/D converter input signal Not used (open)
70	AVDD	_	Power supply terminal (+3.3V) (analog system)
71	ADRT	I(A)	A/D converter operational range upper limit voltage input terminal (fixed at "H" in this set)
72	ADRB	I(A)	A/D converter operational range lower limit voltage input terminal (fixed at "L" in this set)
73	AVSS	_	Ground terminal (analog system)
74	SE	I(A)	Sled error signal input from the CXA2523AR (IC101)
75	TE	I(A)	Tracking error signal input from the CXA2523AR (IC101)
76	DCHG	I(A)	Connected to the +3.3V power supply
77	APC	I(A)	Error signal input for the laser automatic power control Not used (fixed at "H")
78	ADFG	I(S)	ADIP duplex FM signal (22.05 kHz ± 1 kHz) input from the CXA2523AR (IC101)
79	F0CNT	О	Filter f0 control signal output to the CXA2523AR (IC101)
80	XLRF	О	Serial data latch pulse signal output to the CXA2523AR (IC101)
81	CKRF	О	Serial data transfer clock signal output to the CXA2523AR (IC101)
82	DTRF	О	Writing serial data output to the CXA2523AR (IC101)
83	APCREF	О	Control signal output to the reference voltage generator circuit for the laser automatic power control
84	LDDR	О	PWM signal output for the laser automatic power control Not used (open)
85	TRDR	О	Tracking servo drive PWM signal (-) output to the BH6511FS (IC152)
86	TFDR	О	Tracking servo drive PWM signal (+) output to the BH6511FS (IC152)
87	DVDD	_	Power supply terminal (+3.3V) (digital system)
88	FFDR	О	Focus servo drive PWM signal (+) output to the BH6511FS (IC152)
89	FRDR	О	Focus servo drive PWM signal (-) output to the BH6511FS (IC152)

<sup>\*</sup> I (S) stands for schmitt input, I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

Pin No.	Pin Name	I/O	Description		
90	FS4	О	Clock signal (176.4 kHz) output terminal (X'tal system) Not used (open)		
91	SRDR	О	Sled servo drive PWM signal (-) output to the BH6511FS (IC152)		
92	SFDR	О	Sled servo drive PWM signal (+) output to the BH6511FS (IC152)		
93	SPRD	О	Spindle servo drive PWM signal (–) output to the BH6511FS (IC152)		
94	SPFD	О	Spindle servo drive PWM signal (+) output to the BH6511FS (IC152)		
95	FGIN	I(S)			
96	TEST1	I	Input terminal for the test (fixed at "I")		
97	TEST2	I	Input terminal for the test (fixed at "L")		
98	TEST3	I			
99	DVSS		Ground terminal (digital system)		
100	EFMO	О	EFM signal output terminal when recording mode		

<sup>\*</sup> I (S) stands for schmitt input, I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

#### • MAIN BOARD IC501 M30620MC-400FP (SYSTEM CONTROLLER)

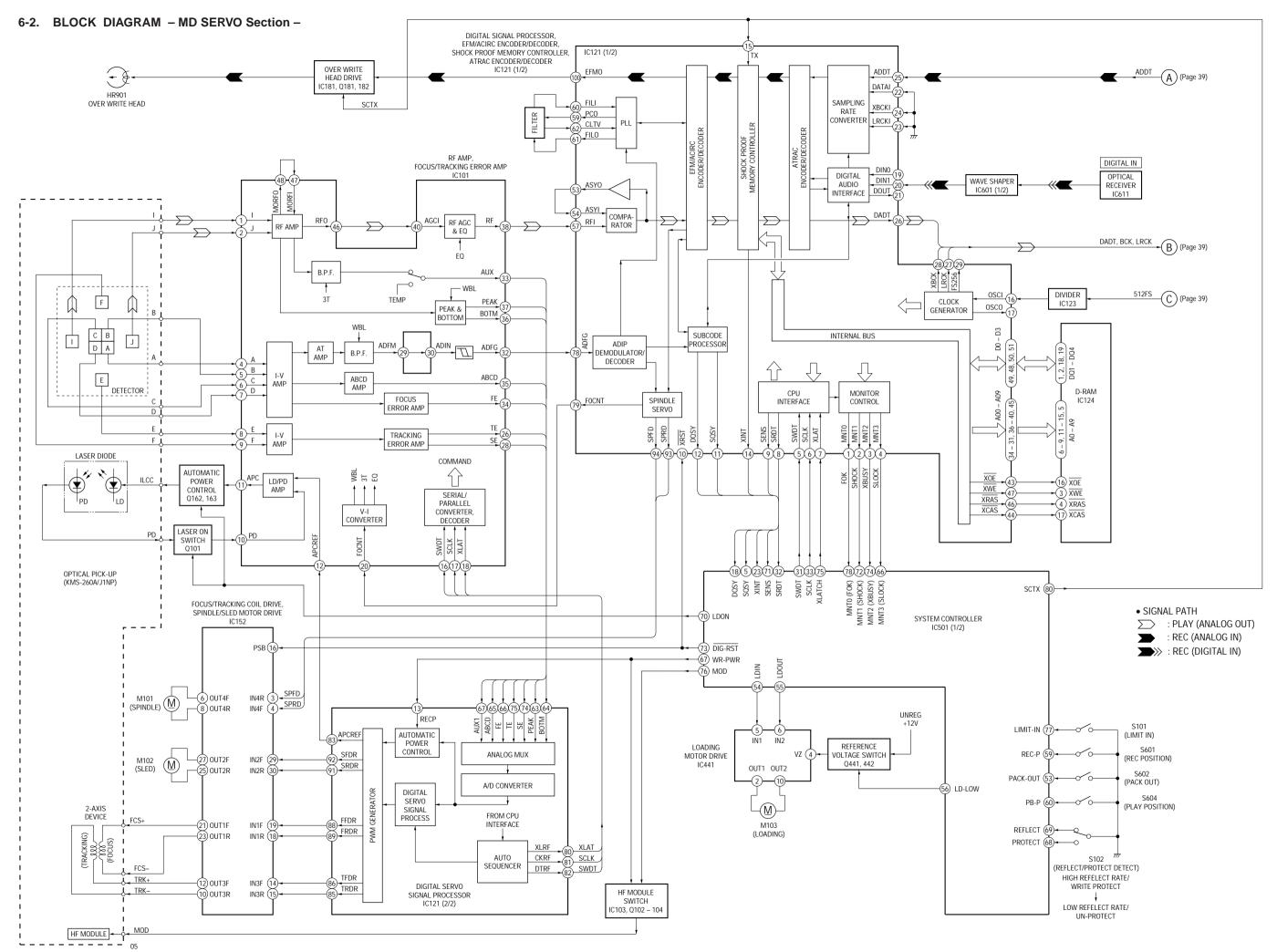
Pin No.	Pin Name	I/O	Description		
1, 2	NC	О	Not used (open)		
3	C1	О	Monitor output terminal for the test C1 error rate is output when test mode		
4	ADER	О	Monitor output terminal for the test ADER is output when test mode		
5	SQSY	I	Subcode Q sync (SCOR) input from the CXD2654R (IC121) "L" is input every 13.3 msec Almost all, "H" is input		
6	RMC	I	Remote control signal input from the remote control receiver (IC781)		
7	A1 IN	I	Sircs remote control signal input of the CONTROL A1 Not used		
8	BYTE	I	External data bus line byte selection signal input "L": 16 bit, "H": 8 bit (fixed at "L")		
9	CNVSS	_	Ground terminal		
10	XT-IN	I	Sub system clock input terminal (32.768 kHz) Not used (fixed at "L")		
11	XT-OUT	О	Sub system clock output terminal (32.768 kHz) Not used (open)		
12	S.RST	I	System reset signal input from the reset signal generator (IC406) "L": reset For several hundreds msec. after the power supply rises, "L" is input, then it changes to "H"		
13	XOUT	О	Main system clock output terminal (10 MHz)		
14	GND	_	Ground terminal		
15	XIN	I	Main system clock input terminal (10 MHz)		
16	+3.3V	_	Power supply terminal (+3.3V)		
17	NMI	I	Non-maskable interrupt input terminal (fixed at "H" in this set)		
18	DQSY	I	Digital In U-bit CD format subcode Q sync (SCOR) input from the CXD2654R (IC121) "L" is input every 13.3 msec Almost all, "H" is input		
19	P.DOWN	I	Power down detection signal input terminal "L": power down, normally: "H"		
20	KEYBOARD CLK	I	Not used (open)		
21	KEYBOARD DATA	I	Not used (open)		
22	BEEP OUT	O	Beep sound drive signal output terminal Not used (open)		
23	XINT	I	Interrupt status input from the CXD2654R (IC121)		
24 to 27	NC	O	Not used (open)		
28	L3-CLOCK	O	Serial data transfer clock signal output to the A/D, D/A converter (IC301)		
29	NC	О	Not used (open)		
30	L3-DATA	O	Serial data output to the A/D, D/A converter (IC301)		
31	SWDT	О	Writing data output to the CXD2654R (IC121)		
32	SRDT	I	Reading data input from the CXD2654R (IC121)		
33	SCLK	О	Serial clock signal output to the CXD2654R (IC121)		
34	FLCS	O	Chip select signal output to the FL/LED driver (IC761)		
35	FLDATA	О	Serial data output to the FL/LED driver (IC761)		
36	NC	О	Not used (open)		
37	FLCLK	О	Serial data transfer clock signal output to the FL/LED driver (IC761)		
38 to 40	NC	О	Not used (open)		
41	NC	I	Not used (fixed at "L")		
42	JOG1	I	JOG dial pulse input from the rotary encoder (S713 ► AMS ► I) (B phase input)		
43	JOG0	I	JOG dial pulse input from the rotary encoder (S713 ► AMS ► I) (A phase input)		
44	NC	0	Not used (open)		
45	A1 OUT	0	Sircs remote control signal output of the CONTROL A1 Not used		
46	NC	I	Not used (fixed at "L")		
47	L3-MODE	0	L3 mode control signal output to the A/D, D/A converter (IC301)		
48	DA RST	0	Reset signal output for the A/D, D/A converter "L": reset Not used (open)		
49	MUTE	О	Audio line muting on/off control signal output terminal "L": line muting on		

Pin No.	Pin Name	I/O	Description			
50	STB	О	Relay drive signal output for the power on/off "L": standby mode, "H": relay on			
51	CHACK IN	I	Detection input from the disc chucking-in detect switch "L": chucking Not used (fixed at "H")			
52	NC	О	Not used (open)			
53	PACK-OUT	I	Detection input from the loading-out detect switch (S602) "L" at a load-out position, others: "H"			
54	LDIN	О	Motor control signal output to the loading motor driver (IC441) "L" active *1			
55	LDOUT	О	Motor control signal output to the loading motor driver (IC441) "L" active *1			
56	LD-LOW	О	Loading motor drive voltage control signal output for the loading motor driver (IC441) "H" active			
57, 58	NC	О	Not used (open)			
59	REC-P	I	Detection input from the recording position detect switch (S601) "L" active			
60	PB-P	I	Detection input from the playback position detect switch (S604) "L" active			
61	REC/PB	О	Not used (open)			
62	+3.3V	_	Power supply terminal (+3.3V)			
63	NC	О	Not used (open)			
64	GND	_	Ground terminal			
65	SDA	I/O	Two-way data bus with the EEPROM (IC171)			
66	MNT3 (SLOCK)	I	Spindle servo lock status monitor signal input from the CXD2654R (IC121)			
67	WR-PWR	О	Laser power select signal output to the CXD2654R (IC121) and HF module switch circuit "L": playback mode, "H": recording mode			
68	PROTECT	I	Rec-proof claw detect input from the protect detect switch (S102) "H": write protect			
69	REFLECT	I	Detection input from the disc reflection rate detect switch (S102) "L": high reflection rate disc, "H": low reflection rate disc			
70	LDON	О	Laser diode on/off control signal output to the automatic power control circuit "H": laser on			
71	SENS	I	Internal status (SENSE) input from the CXD2654R (IC121)			
72	MNT1 (SHOCK)	I	Track jump detection signal input from the CXD2654R (IC121)			
73	DIG-RST	О	Reset signal output to the CXD2654R (IC121) and BH6511FS (IC152) "L": reset			
74	MNT2 (XBUSY)	I	Busy signal input from the CXD2654R (IC121)			
75	XLATCH	О	Serial data latch pulse signal output to the CXD2654R (IC121)			
76	MOD	0	Laser modulation select signal output to the HF module switch circuit Playback power: "H", Stop: "L", Recording power:			
77	LIMIT-IN	I	Detection input from the sled limit-in detect switch (S101) The optical pick-up is inner position when "L"			
78	MNT0 (FOK)	I	Focus OK signal input from the CXD2654R (IC121) "H" is input when focus is on ("L": NG)			

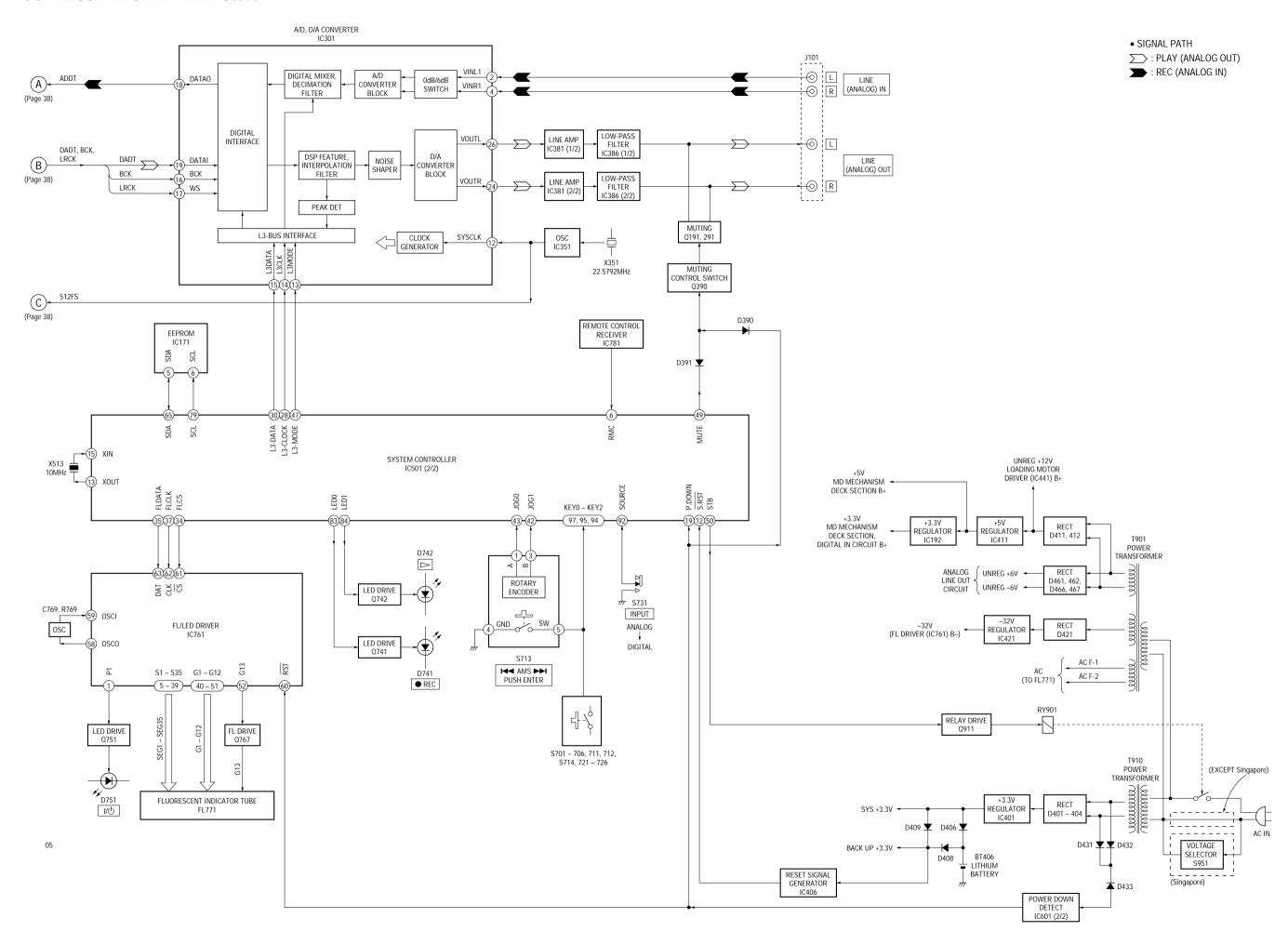
#### \*1 Loading motor (M103) control

Mode Terminal	LOADING	EJECT	BRAKE	RUN IDLE
LDIN (pin 🚳)	"L"	"H"	"L"	"H"
LDOUT (pin 65)	"H"	"L"	"L"	"H"

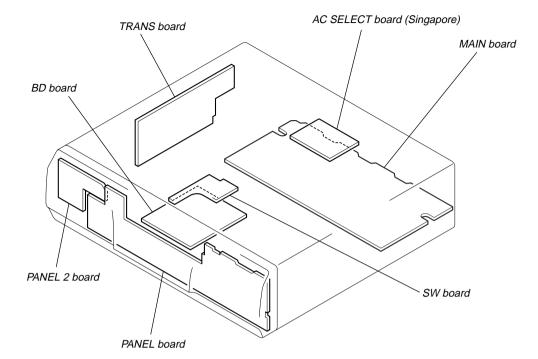
Pin No.	Pin Name	I/O	Description			
79	SCL	О	Clock signal output to the EEPROM (IC171)			
80	SCTX	O	Recording data output enable signal output to the CXD2654R (IC121) and overwrite head driver (IC181) Writing data transmission timing output (Also serves as the magnetic head on/off output)			
81	CLOCK SET0	I	Destination setting terminal (US and Canadian models: fixed at "L", AEP, UK and E models: fixed at "H")			
82	CLOCK SET1	I	Destination setting terminal (US and Canadian models: fixed at "H", AEP, UK and E models: fixed at "L")			
83	LED0	О	LED drive signal output of the ● REC indicator (D741) "L": LED on			
84	LED1	О	LED drive signal output of the ▶ indicator (D742) "L": LED on			
85	OPT SEL0	О	Not used (open)			
86	OPT SEL1	О	Not used (open)			
87	MODEL SEL0	I	Setting terminal for the model (fixed at "H" in this set)			
88	MODEL SEL1	I	Setting terminal for the model (Not used (open))			
89	REC	О	Not used (open)			
90	BEEP SW	I	BEEP switch input terminal "L": beep off, "H": beep on Not used			
91	NC	О	Not used (open)			
92	SOURCE	I	INPUT switch (S731) input terminal (A/D input) "L": digital input, "H": analog input			
93	KEY3	I	Key input terminal (A/D input) Not used (fixed at "H")			
94	KEY2	I	Key input terminal (A/D input) S721 to S726 (EJECT ♠, PLAY MODE, REPEAT, SCROLL, LEVEL/DISPLAY/CHAR, I/U keys input)			
95	KEY1	I	Key input terminal (A/D input) S711 to S714 (MENU/NO, YES, PUSH ENTER, CLEAR keys input)			
96	AVSS	_	Ground terminal			
97	KEY0	I	Key input terminal (A/D input) S701 to S706 (♠ REC, ■, ▶▶, ◄◄, ▮, ▷ keys input)			
98	VREF	I	Reference voltage (+3.3V) input terminal (for A/D converter)			
99	+3.3V	_	Power supply terminal (+3.3V) (for analog system)			
100	MONO/ST	I	Recording mode switch input terminal "L": mono, "H": stereo Not used (open)			



#### 6-3. BLOCK DIAGRAM - MAIN Section -



#### • Circuit Boards Location



#### 6-4. NOTE FOR PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS

#### Note on Printed Wiring Board:

• • — : parts extracted from the component side. — : parts extracted from the conductor side.

• parts mounted on the conductor side.

• O : Through hole.

Pattern from the side which enables seeing.

Caution:

Pattern face side: Parts on the pattern face side seen from (Side B) the pattern face are indicated. Parts face side: Parts on the parts face side seen from the parts face are indicated. (Side A)

• Indication of transistor.

0/0\0  $\frac{B}{A} \stackrel{C}{\stackrel{}{\downarrow}} E$ 

These are omitted.

Abbreviation

CND : Canadian model : Singapore model

#### Note on Schematic Diagram:

- All capacitors are in μF unless otherwise noted. pF: μμF 50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in  $\Omega$  and  $^{1}/_{4}$ W or less unless otherwise specified.

• % : indicates tolerance.

•  $\triangle$  : internal component.

• \_\_\_\_\_ : panel designation.

#### Note: Les composants identifiés par une marque \( \triangle \) sont critiques

The components identified by mark △ or dotted line with mark  $\triangle$  are critical for safety.

Replace only with part piéce portant le numéro number specified.

• B + : B+ Line. • B - : B- Line.

Note:

• Voltages and waveforms are dc with respect to ground in playback mode.

spécifié.

pour la sécurité.

Ne les remplacer que par une

- Voltages are taken with a VOM (Input impedance 10 M $\Omega$ ). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with a oscilloscope. Voltage variations may be noted due to normal production tolerances.
- · Circled numbers refer to waveforms.

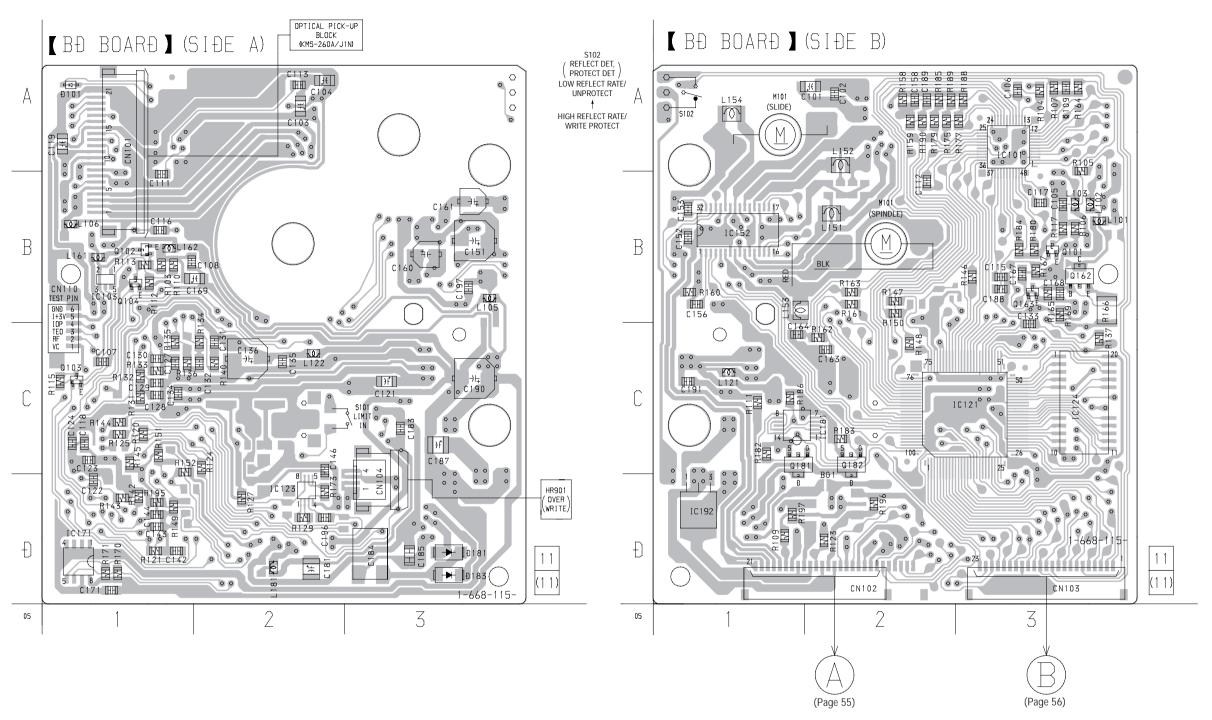
• Signal path.

∑ : PLAY (ANALOG OUT) : REC (ANALOG IN)
: REC (DIGITAL IN)

Abbreviation

CND : Canadian model : Singapore model

#### 6-5. PRINTED WIRING BOARD - BD Board - • See page 41 for Circuit Boards Location.

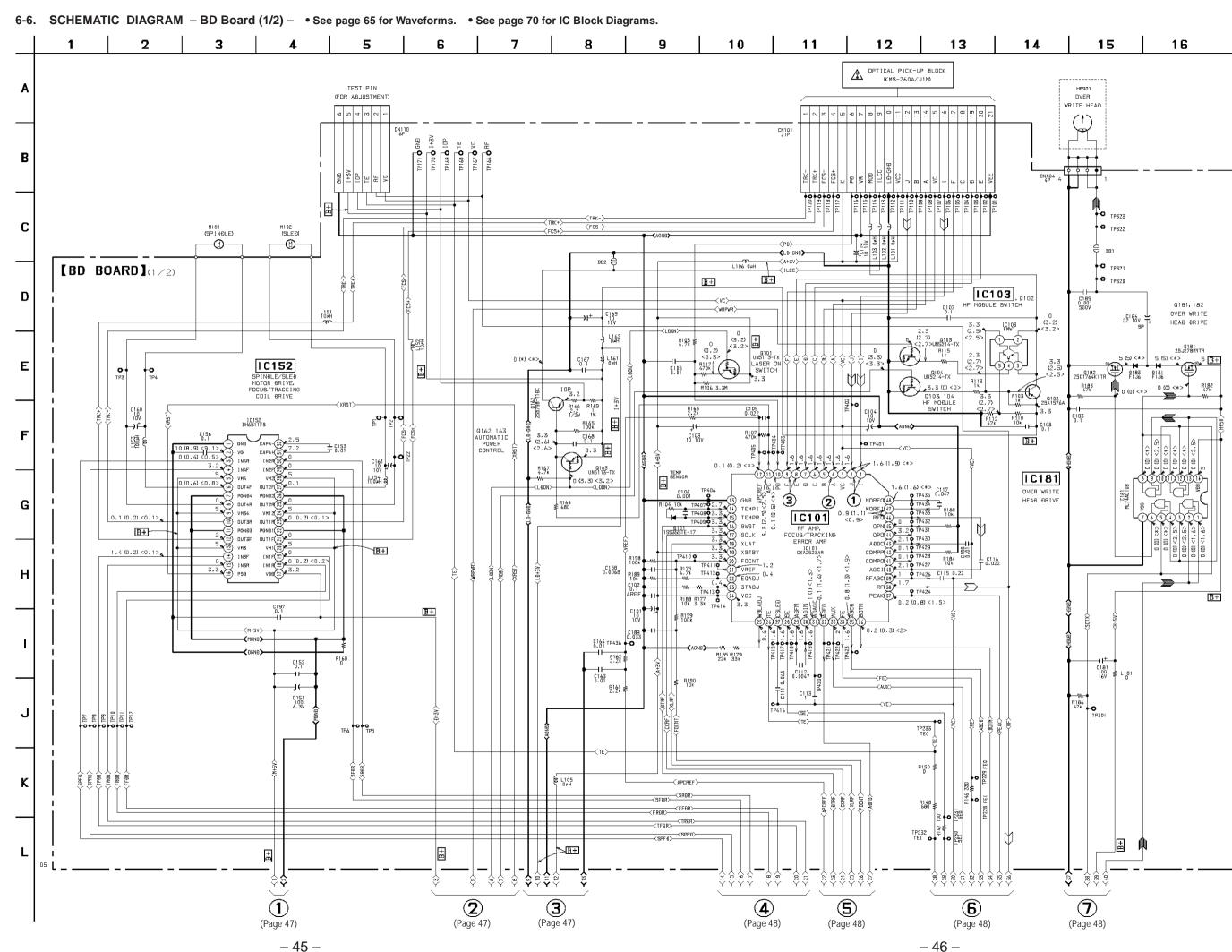


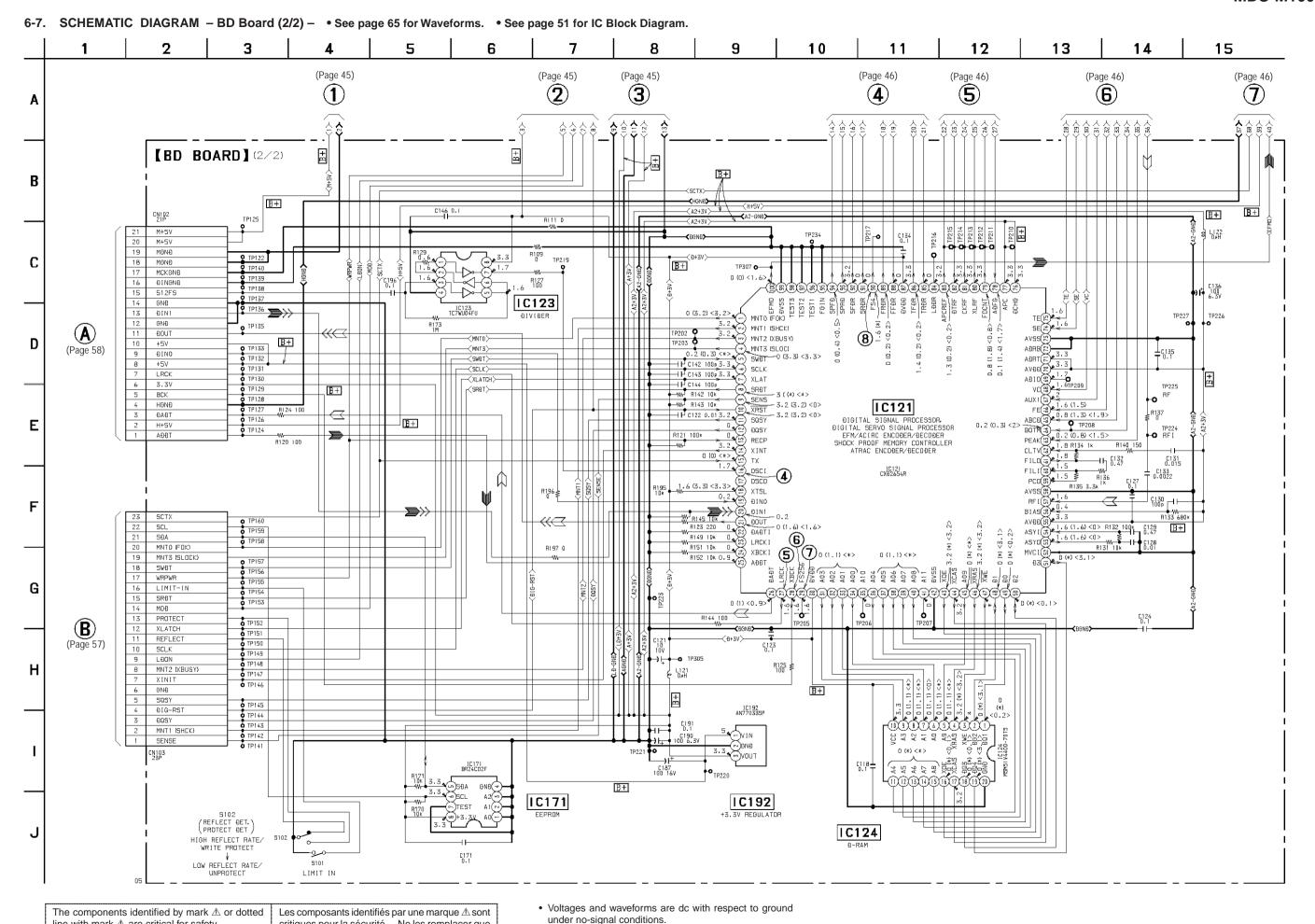
#### • Semiconductor Location

Ref. No.	Location
D101	A-1
D181	D-3
D183	D-3
IC103 IC123 IC171	B-1 D-2 D-1
Q102 Q103 Q104	B-1 C-1 B-1

#### Semiconductor Location

Ref. No.	Location
IC101	A-3
IC121	C-3
IC124	C-3
IC152	B-1
IC181	C-1
IC192	D-1
Q101	B-3
Q162	B-3
Q163	B-3
Q181	C-1
Q182	C-2





no mark : STOP

):PLAY > : REC

\* : Impossible to measure

**- 47 -**

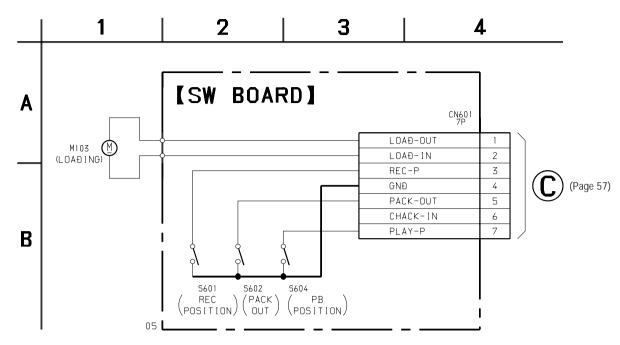
critiques pour la sécurité. Ne les remplacer que

par une piéce portant le numéro spécifié.

line with mark  $\triangle$  are critical for safety.

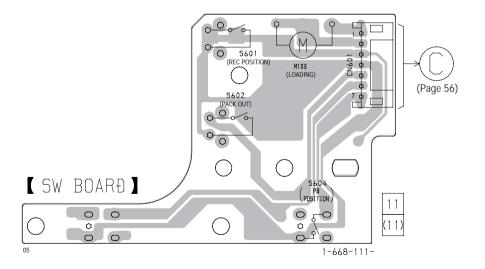
Replace only with part number specified.

#### 6-8. SCHEMATIC DIAGRAM - SW Board -



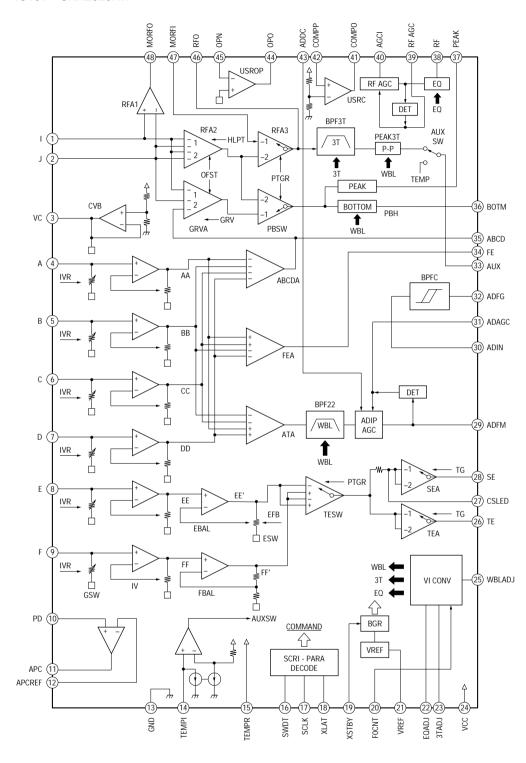
#### 6-9. PRINTED WIRING BOARD - SW Board -

• See page 41 for Circuit Boards Location.

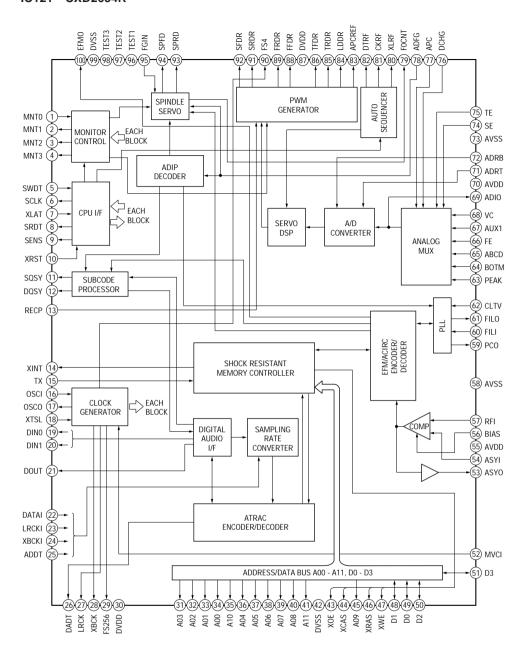


- IC Block Diagrams
- BD Board -

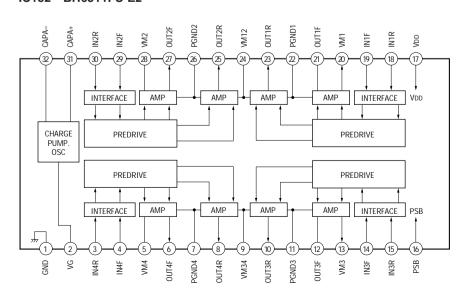
#### IC101 CXA2523AR



#### IC121 CXD2654R

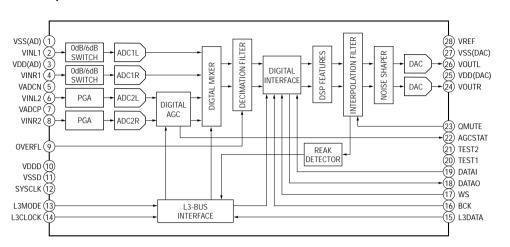


#### IC152 BH6511FS-E2

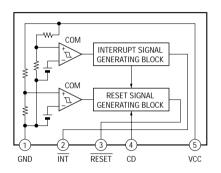


#### - MAIN Board -

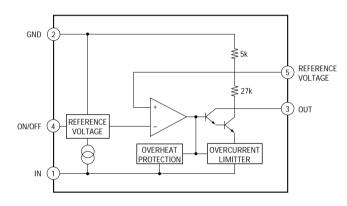
#### IC301 μDA1341TS/N2



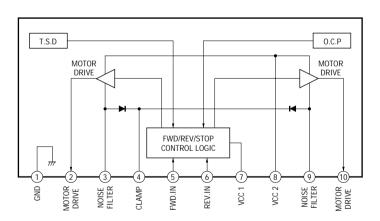
IC406 M62016L



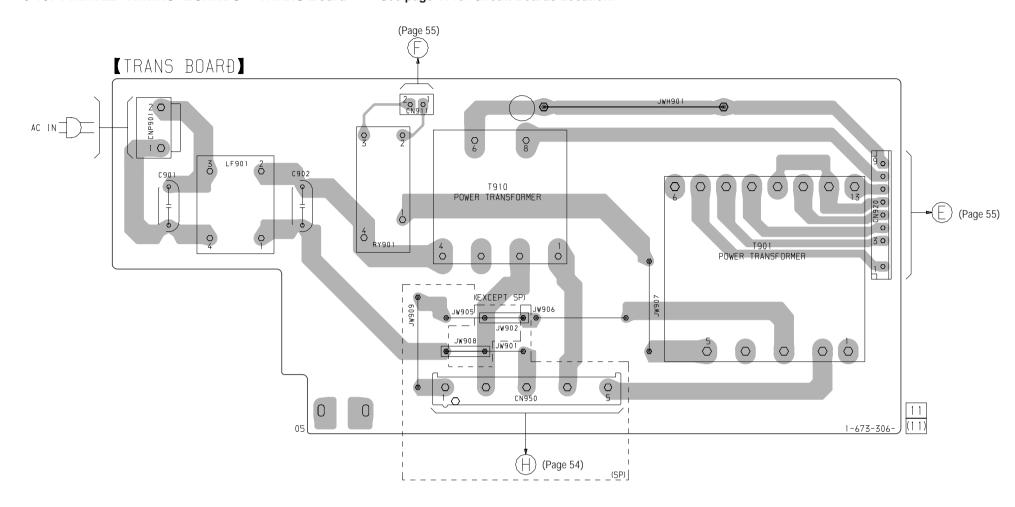
IC421 M5293L

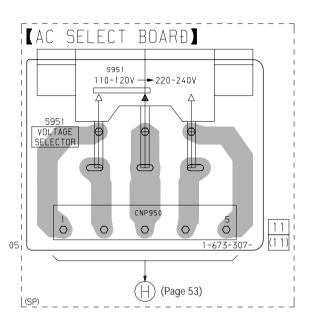


#### IC441 LB1641

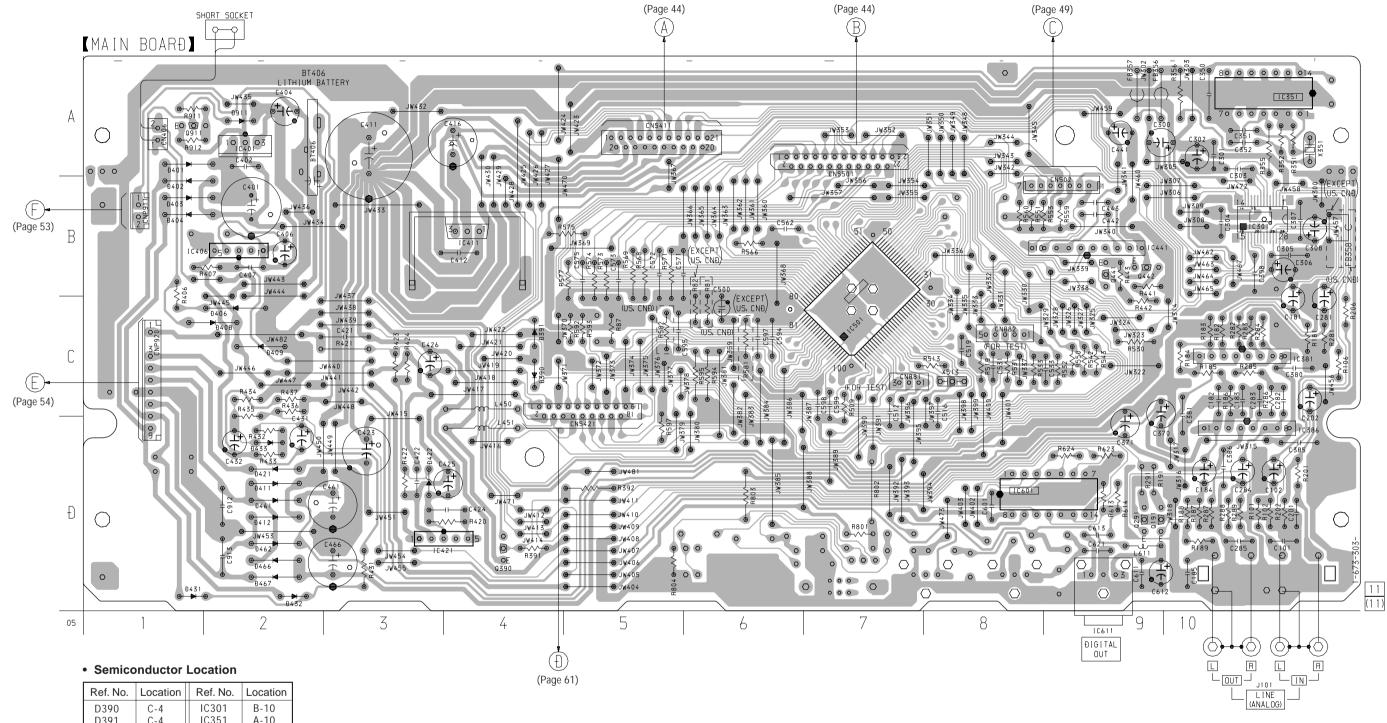


#### 6-10. PRINTED WIRING BOARDS -TRANS Board - • See page 41 for Circuit Boards Location.





#### 6-11. PRINTED WIRING BOARD - MAIN Board - • See page 41 for Circuit Boards Location.



Ref. No.	Location	Ref. No.	Location
D390	C-4	IC301	B-10
D391	C-4	IC351	A-10
D401	A-1	IC381	C-10
D402	B-1	IC386	D-10
D403	B-1	IC401	A-2
D404	B-1	IC406	B-2
D406	C-2	IC411	B-4
D408	C-2	IC421	D-3
D409	C-2	IC441	B-9
D411	D-2	IC501	C-7
D412	D-2	IC601	D-9
D421	D-2	IC611	D-9
D422	D-3		
D431	D-1	Q191	D-9
D432	D-2	Q291	D-9
D433	D-2	Q390	D-4
D461	D-2	Q441	B-9
D462	D-2	Q442	B-9
D466	D-2	Q911	A-1
D467	D-2		
D911	A-2		

6-12. SCHEMATIC DIAGRAM - MAIN Board (1/2) - • See page 65 for Waveform. 5 6 7 8 9 | 10 | 11 | 12 | 13 14 | 15 16 3 | 17 [MAIN BOARD] (1/2) Α M+5V MGNĐ  $\Longrightarrow >>$  $\Longrightarrow \gg$ R437 ≢ **\*** 4 5 6 7 8 9 10 11 12 IC611 MURGNE B+ ÐINGNÐ DPT I CAL RECE ( VER IC601 512FS 1C611 GP1F38R WAVE SHAPER POWER ĐOWN ĐETECT (C401 SN74HCU04AN В VCC (3) 3.3 GNĐ A B+ Ð-DUT ICA11 DIGITAL IN +5V Ð-INO OUT 1 2-8 (Page 47) 14 15 16 B+ B+ LRCK 3.3 BCK H.GNĐ 17 18 19 C 6-01 ¥ R624 R435 56k ĐAĐT H+5V B+ CN411 21P ≸R530 ≰R519 ⊞ B+ **B**+ B+ D R801 B+ 5 TXÐ1 4 RTS1 **(1**) A2 田 B+ 3 SYS3.3V FOR TEST 32 B1 (Page 59) CLK1 RXB1 Ε CN501 23P XS13 10MHz 23 SENSE 22 MNT1 (SHOCK C519+ B1 CN881 ĐQSY T3 B2 ÷ GNÐ RESET F 16 MNTO (X-BUSY)
15 Ladn
14 SCLK REFRECT **(B)** R532 10k XLATCH PROTECT (Page 47) BOM 0.2 (51) SWBT M 0.2 (33) SRBT 3 (33) SRBT 2.6 (34) FLCS 0 (35) FLDATA B+ MOND/ST 100 3 +3.3V 99 3.3 VREF 93 3.3 KEY0 97 3.3 9 8 7 G SRÐT 涸 L1M1T-IN T11 6 SWÐT 5 MNT3 (S-LOCK 4 MNT0 (F-OK) KEY0 (97)

AV55 (94)

KEY1 (95)

KEY2 (94)

3.3

KEY3 (93)

3.3

KEY3 (93)

3.3 MNT3 (S-LOCK) (3) FLBATA (3) NC (3) NC (3) NC (3) NC (4) NC (4) NC (5) JOSO (4) NC (6) AT OUT (6) NC - W- 8595 10v F 2 •-W-• R594 10k E3 3 SĐA T15 | SOUTHOLLER | SET (3) | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | -W- R593 SCL SCTX T16 I C501 Н CN502 H592 10k 1C501 M30620MC-400FP PLAY-P SW R804 R803 R543 10k 4.7k 10k CHACK-IN SW B+ R87 100 k PACK-OUT SW 3 REC-P Sw 2 LOAD-OUT LOAD-IN 3 48 DA RST 3 49 MUTE Z 500 STB (Page 49) **B**+ (US, CNĐ)

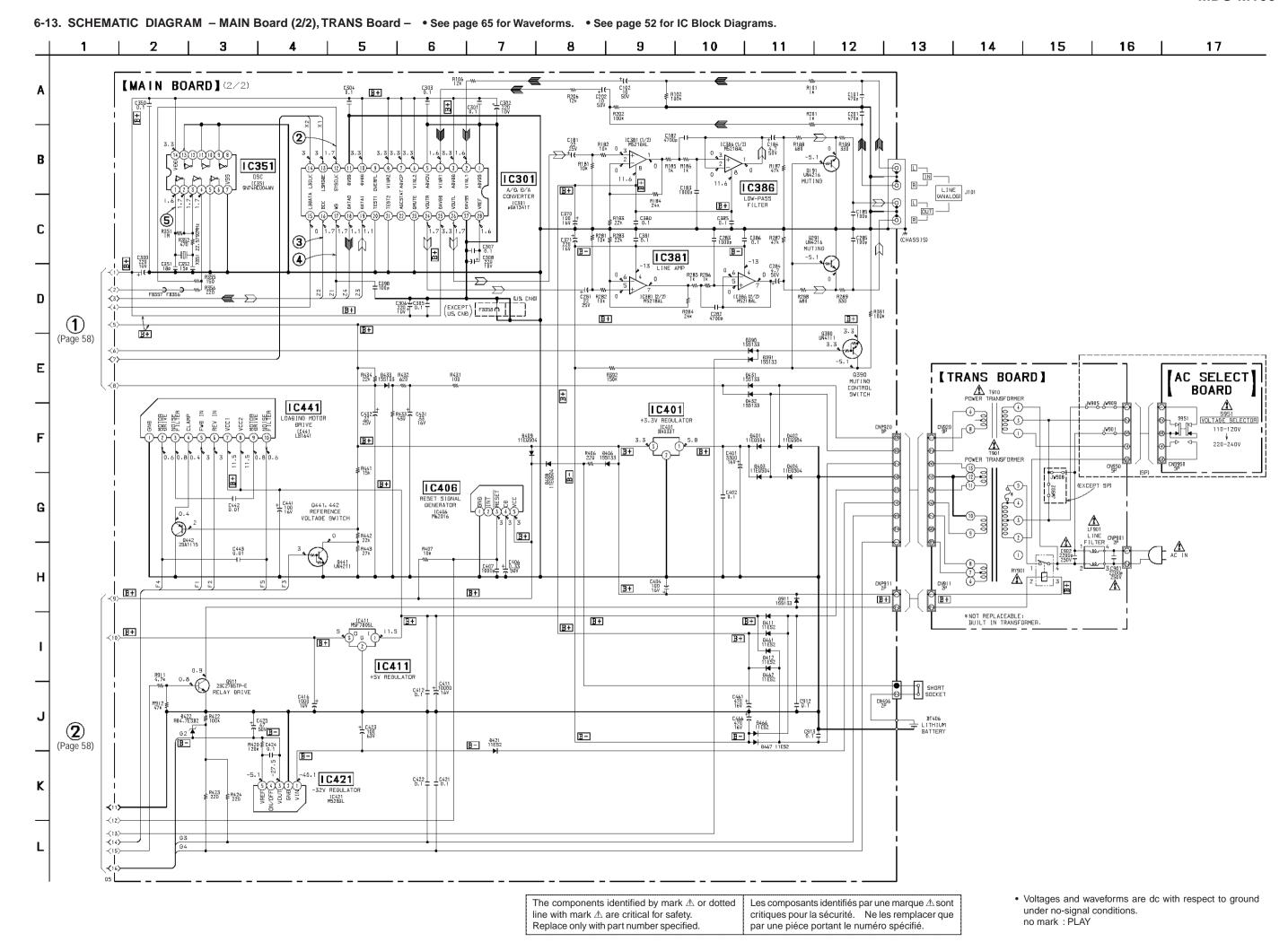
R582

W. 100k

R581

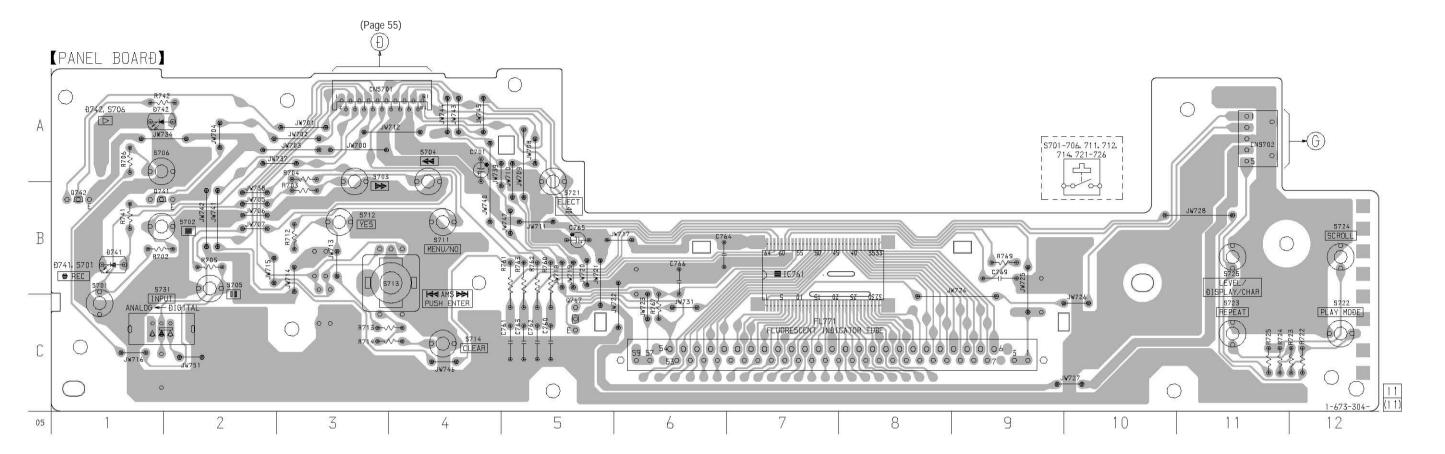
L451 R550 NS421 19 LEÐ 1 (PLAY) 18 LEÐ 0 (REC) E6 94 95 E4 R81 ≠ F882 1881 × ≠ 1864 J0G 0 J0G 1 (EXCEPT US. CND) SOURCE 14 KEY 0
13 KEY 1
12 KEY 2
11 FLCS **B**+ (Page 59)  $(\mathbf{D})$ R551 € R559 10k ≢ B+ FLÐT B+ R548 10k R549 10k H549 10p H1 C571 10p H1 C572 10p H1 C573 10p H1 C573 10p (Page 64) 9 FLCLK B STBY 3.3V R574 R573 ≸ 10k ≸ 10k # s2 R575 B+ P. ĐOWN SYS 3.3V 图力 RMC 5Y5 G C426 22 63V F1 F3 G2 | G3 <12> -327 <13≻ AC **≺**14≻ B-<15≻ |

Voltages and waveforms are dc with respect to ground under no-signal conditions.
 no mark: PLAY



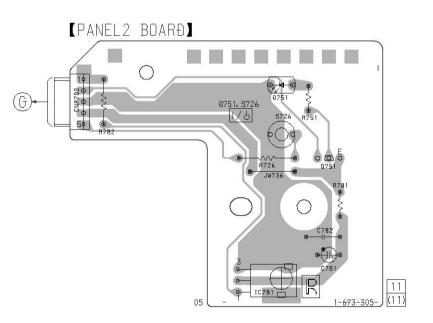
### MDS-M100

#### 6-14. PRINTED WIRING BOARDS - PANEL/PANEL 2 Boards - • See page 41 for Circuit Boards Location.

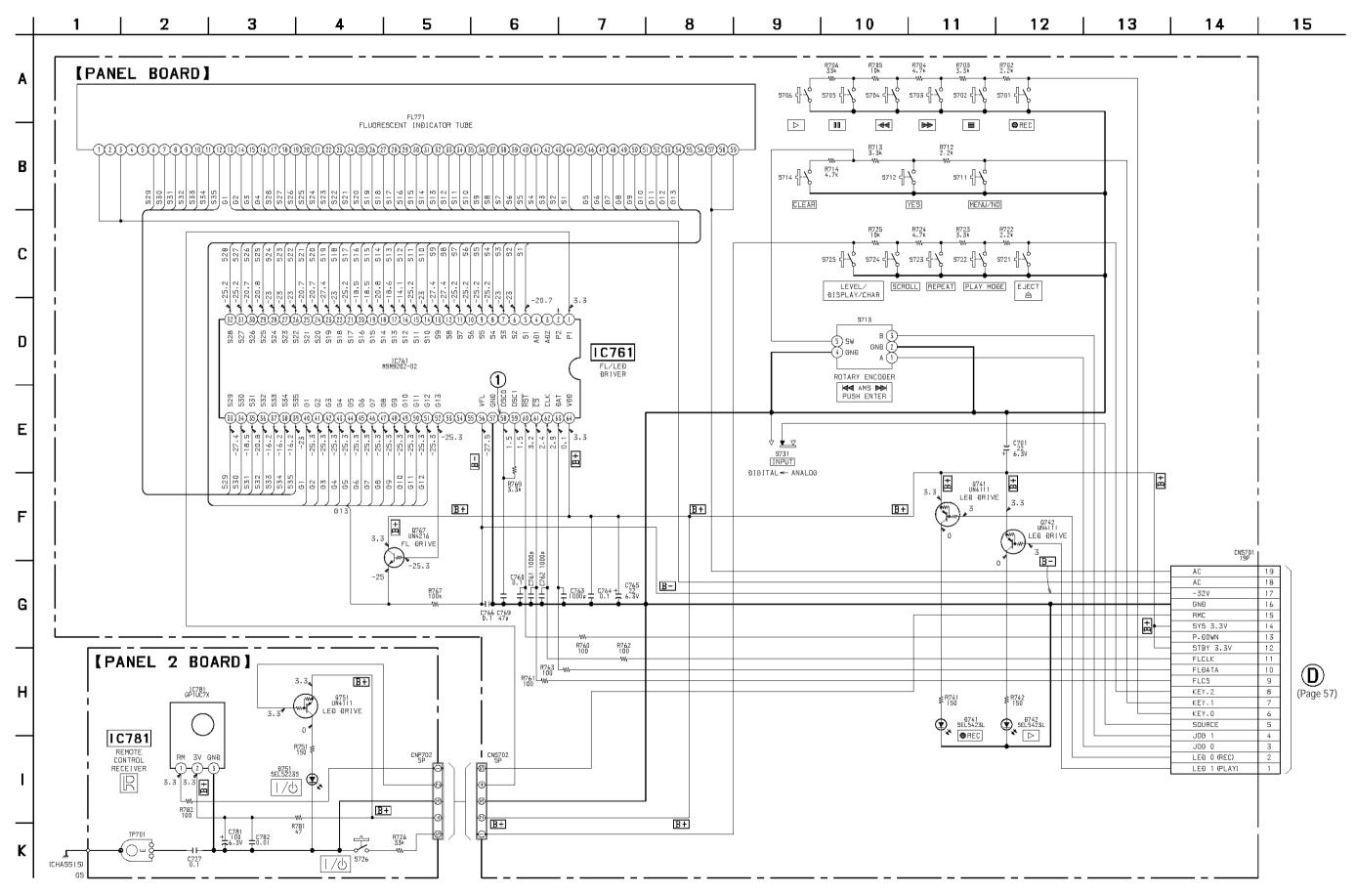


#### • Semiconductor Location

Ref. No.	Location
D741	B-1
D742	A-1
IC761	B-7
Q741	B-1
Q742	B-1
Q767	C-5



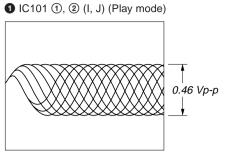
#### 6-15. SCHEMATIC DIAGRAM - PANEL/PANEL 2 Boards - • See page 65 for Waveform.



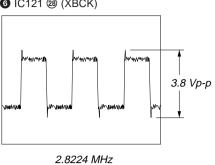
Voltages and waveforms are dc with respect to ground under no-signal conditions.
 no mark: STOP

#### Waveforms

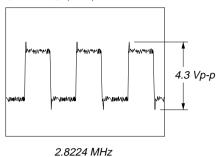
#### - BD Board -



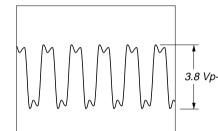
6 IC121 28 (XBCK)



3 IC301 (6 (BCK)

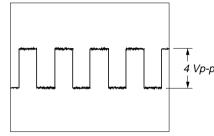






11.29 MHz

4 IC301 17 (WS)



44.1 kHz

22.5792 MHz

1.6 Vp-p

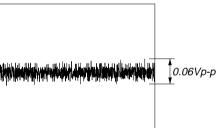
- PANEL Board -1 IC761 58 (OSC0)

540 ns

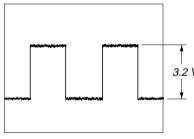
**6** IC351 ①

3 IC101 8, 9 (E, F) (Play mode)

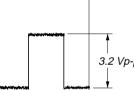
2 IC101 4 (A) (Play mode)



3 IC121 99 (FS4)



176.4 kHz



2.6 Vp-p

#### - MAIN Board -

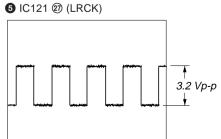


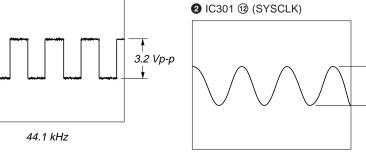
10 MHz

0.1 Vp-p

22.581 MHz

4 IC121 (6 (OSCI)





22.5792 MHz

### **SECTION 7 EXPLODED VIEWS**

#### NOTE:

- -XX and -X mean standardized parts, so they may have some difference from the original
- Color Indication of Appearance Parts Example:

KNOB, BALANCE (WHITE) . . . (RED)

Parts Color Cabinet's Color

 Abbreviation CND: Canadian model SP : Singapore model

• Items marked "\*" are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.

• The mechanical parts with no reference number in the exploded views are not supplied.

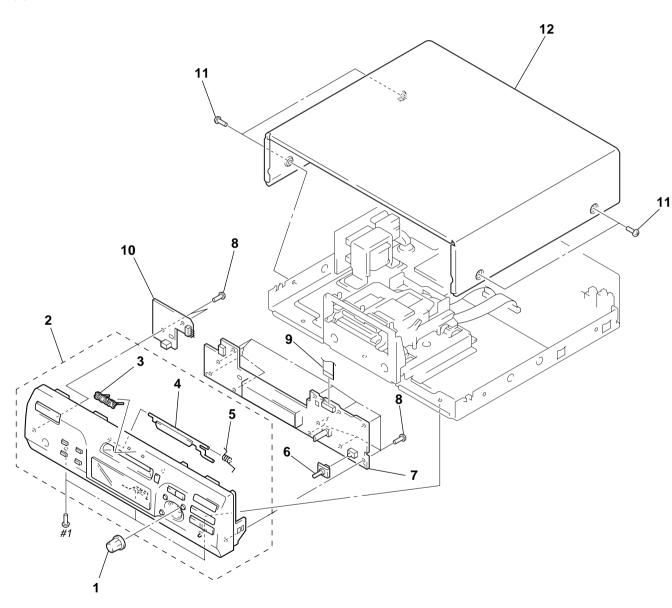
• Hardware (# mark) list and accessories and packing materials are given in the last of the electrical parts list.

The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque 🛆 sont critiquens pour la sécurité.

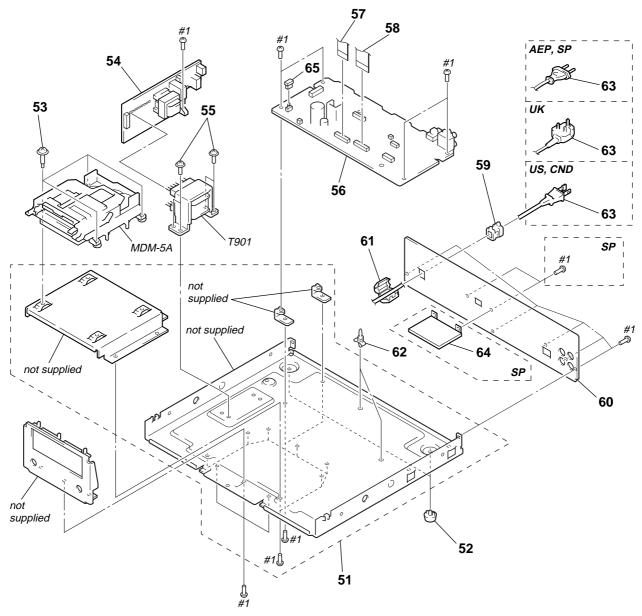
Ne les remplacer que par une pièce portant le numéro spécifié.

#### (1) COVER SECTION



Ref. No.	Part No.	Description	<u>Remark</u>	Ref. No.	Part No.	Description	<u>Remark</u>
1	4-216-828-01	KNOB (AMS)		* 7	A-4724-590-A	PANEL BOARD, COMPLETE	
2	X-4951-046-1	FRONT PANEL ASSY		8	4-951-620-01	SCREW (2.6X8), +BVTP	
3	4-996-698-01	EMBLEM, SONY		9	1-790-510-11	WIRE (FLAT TYPE) (19 CORE)	
4	4-996-690-12	LID (CARTRIDGE)		* 10	1-673-305-11	PANEL 2 BOARD	
5	4-976-593-11	SPRING (LID), TORSION		11	3-363-099-01	SCREW (CASE 3 TP2)	
6	4-989-517-21	KNOB (INPUT)		* 12	4-216-839-01	COVER	

#### (2) CHASSIS SECTION

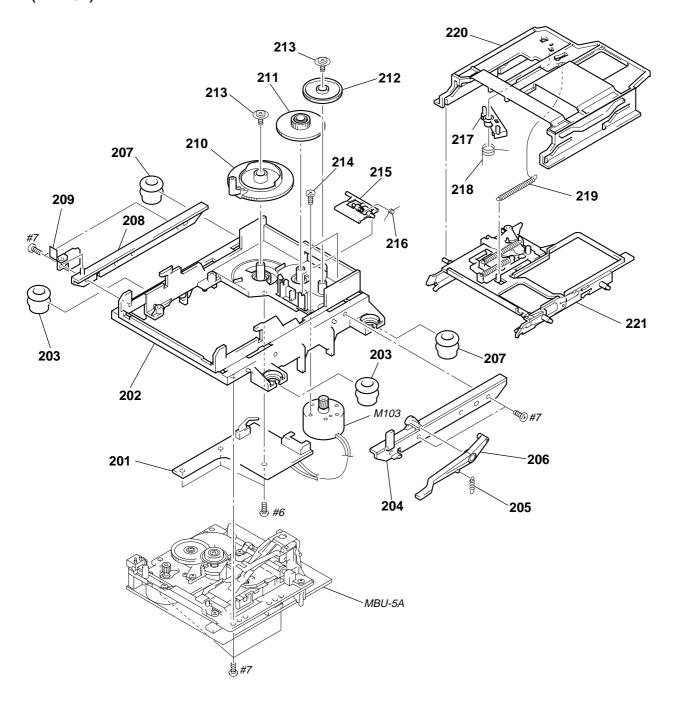


The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque  $\triangle$  sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

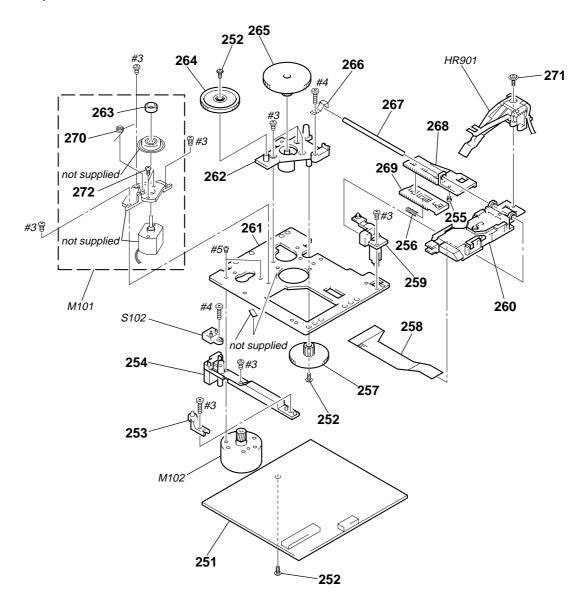
Ref. No.	Part No.	<u>Description</u>	<u>Remark</u>	Ref. No.	Part No.	<u>Description</u>	<u>Remark</u>
* 51	X-4951-211-1	CHASSIS ASSY		* 60	4-216-840-21	BACK PANEL (SP)	
52	4-965-822-01	FOOT		* 60	4-216-840-31	BACK PANEL (AEP)	
53	4-999-839-01	SCREW (+BVTTWH M3), STEP		* 60	4-216-840-41	BACK PANEL (UK)	
* 54	1-673-306-11	TRANS BOARD		61	1-500-051-11	BEAD, FERRITE (WITH CASE)	
55	3-703-249-01	SCREW, S TIGHT, +PTTWH 3X6		62	4-943-687-01	HOLDER, PC BOARD	
* 56	A-4724-589-A	MAIN BOARD, COMPLETE (US, CND)	)	<b>1 ∆</b> 63	1-696-586-21	CORD, POWER (UK)	
* 56	A-4724-628-A	MAIN BOARD, COMPLETE (SP)		<b>1 ∆</b> 63	1-777-071-31	CORD, POWER (AEP, SP)	
* 56	A-4724-631-A	MAIN BOARD, COMPLETE (AEP, UK)		<b>1 ∆</b> 63	1-783-531-31	CORD, POWER (US, CND)	
57	1-790-512-11	WIRE (FLAT TYPE) (21 CORE)		* 64	1-673-307-11	AC SELECT BOARD (SP)	
58	1-790-513-11	WIRE (FLAT TYPE) (23 CORE)		65	1-569-972-21	SOCKET, SHORT 2P	
* 59	3-703-244-00	BUSHING (2104), CORD		<b> ⚠</b> T901	1-433-697-11	TRANSFORMER, POWER (US, CND)	
* 60	4-216-840-01	BACK PANEL (US)		<b> ⚠</b> T901	1-433-698-11	TRANSFORMER, POWER (AEP, UK)	
* 60	4-216-840-11	BACK PANEL (CND)		<b> ⚠</b> T901	1-433-699-11	TRANSFORMER, POWER (SP)	

# (3) MECHANISM SECTION (MDM-5A)



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	<u>Remark</u>
* 201	1-668-111-11	SW BOARD		212	4-996-221-01	GEAR (B)	
* 202	4-996-217-01	CHASSIS		213	4-933-134-01	SCREW (+PTPWH M2.6X6)	
203	4-996-223-11	INSULATOR (F) (BLACK)		214	4-996-224-01	SCREW (1.7X3), +PWH	
* 204	4-996-218-01	BRACKET (GUIDE R)		215	4-996-227-01	LEVER (HEAD)	
205	4-996-277-01	SPRING (O/C), TENSION		216	4-996-229-01	SPRING (HEAD LEVER), TORSION	
206	4-996-226-01	LEVER (O/C)		217	4-996-212-01	LEVER (LIMITTER)	
207	4-999-347-01	INSULATOR (R) (GREEN)		218	4-996-213-01	SPRING (LIMITTER), TORSION	
* 208	4-996-225-01	BRACKET (GUIDE L)		219	4-996-216-01	SPRING (HOLDER), TENSION	
209	4-988-466-11	SPRING (ELECTROSTATIC), LEAF		* 220	4-996-211-01	SLIDER (CAM)	
210	4-996-219-01	GEAR (CAM GEAR)		221	A-4680-409-A	HOLDER COMPLETE ASSY	
211	4-996-220-01	GEAR (A)		M103	X-4949-670-1	MOTOR ASSY, LOADING	

# (4) BASE UNIT SECTION (MBU-5A)



The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque ⚠ sont critiques pour la sécurité.

Ne les remplacer que par une pièce portant le numéro spécifié.

Ref. No.	Part No.	<u>Description</u>	Remark	Ref. No.	Part No.	<u>Description</u>	<u>Remark</u>
251	A-4724-063-A	BD BOARD, COMPLETE		264	4-996-260-01	GEAR (SL-A)	
252	3-372-761-01	SCREW (M1.7), TAPPING		265	4-996-261-01	GEAR (SL-B)	
* 253	4-996-267-01	BASE (BU-D)		266	4-996-264-01	SPRING (SHAFT), LEAF	
* 254	4-996-255-01	BASE (BU-C)		267	4-996-265-01	SHAFT, MAIN	
255	4-900-590-01	SCREW, PRECISION SMALL		268	4-996-256-11	SL (BASE)	
256	4-996-258-01	SPRING, COMPRESSION		269	4-996-257-01	RACK (SL)	
257	4-996-262-01	GEAR (SL-C)		270	4-996-263-01	SPRING (CLV), TORSION	
* 258	1-667-954-11	FLEXIBLE BOARD		271	4-988-560-01	SCREW (+P 1.7X6)	
* 259	4-210-664-11	BASE (BU-A)		272	4-211-036-01	SCREW (1.7X2.5), +PWH	
<b>1</b> ∆ 260	8-583-028-02	OPTICAL PICK-UP KMS-260A/J1N		HR901	1-500-502-11	HEAD, OVER WRITE	
* 261	4-996-252-01	CHASSIS, BU		M101	A-4672-516-A	MOTOR ASSY, SPINDLE	
* 262	4-996-254-01	BASE (BU-B)		M102	A-4672-515-A	MOTOR ASSY, SLED	
263	4-967-688-11	MAGNET, ABSORPTION		S102	1-762-148-21	SWITCH, PUSH (2 KEY)	
						(REFLECT DET, PROT	(ECT DET)

## AC SELECT BD

# SECTION 8 ELECTRICAL PARTS LIST

#### NOTE:

- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- -XX and -X mean standardized parts, so they may have some difference from the original one.
- RESISTORS

All resistors are in ohms. METAL: Metal-film resistor.

METAL OXIDE: Metal oxide-film resistor.

F: nonflammable Abbreviation

CND : Canadian model SP : Singapore model

 Items marked "\*" are not stocked since they are seldom required for routine service.
 Some delay should be anticipated when ordering these items.

SEMICONDUCTORS

 $\begin{array}{ll} \text{In each case, u: } \mu, \text{ for example:} \\ uA. . & : \mu A. . & uPA. . : \mu PA. . \\ uPB. . : \mu PB. . & uPC. . : \mu PC. . \end{array}$ 

uPD. . : μPD. . CAPACITORS

uF: μF
• COILS
uH: μH

The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque  $\triangle$  sont critiquens pour la sécurité.

Ne les remplacer que par une pièce portant le numéro spécifié.

When indicating parts by reference number, please include the board.

Ref. No.	Part No.	Description			Remark	Ref. No.	Part No.	Description			Remark
		•	ND (OD)					<u> </u>	40005	F0/	
*	1-6/3-30/-11	AC SELECT BOAF	` '			C142	1-163-251-11		100PF	5%	50V
		*********	c alc			C143		CERAMIC CHIP	100PF	5%	50V
						C144		CERAMIC CHIP	100PF	5%	50V
		< SWITCH >				C146	1-163-038-00	CERAMIC CHIP	0.1uF		25V
<b></b> \$951	1-771-474-11	SWITCH, POWER	(VOLTAGE	SELECT	OR)	C151	1-126-206-11	ELECT CHIP	100uF	20%	6.3V
*******	******	*******	******	******	******	C152	1-163-038-00	CERAMIC CHIP	0.1uF		25V
						C153	1-163-021-11	CERAMIC CHIP	0.01uF	10%	50V
	A-4724-063-A	BD BOARD, COM	PLETE			C156	1-163-038-00	CERAMIC CHIP	0.1uF		25V
		*****	****			C158	1-163-019-00	CERAMIC CHIP	0.0068uF	10%	50V
		CADACITOD				01/0	1-104-601-11	ELECT CLUD	10	200/	101/
		< CAPACITOR >				C160			10uF 10uF	20%	10V 10V
0101	1 105 000 11	TANITALLINA	10	200/	101/	C161	1-104-601-11			20%	
C101	1-125-822-11		10uF	20%	10V	C163		CERAMIC CHIP	0.01uF	10%	50V
C102		CERAMIC CHIP	0.1uF	000/	25V	C164		CERAMIC CHIP	0.01uF	10%	50V
C103	1-125-822-11		10uF	20%	10V	C167	1-163-038-00	CERAMIC CHIP	0.1uF		25V
C104	1-125-822-11		10uF	20%	10V						
C105	1-163-021-11	CERAMIC CHIP	0.01uF	10%	50V	C168		CERAMIC CHIP	0.1uF		25V
						C169	1-125-822-11		10uF	20%	10V
C106		CERAMIC CHIP	0.001uF	5%	50V	C171		CERAMIC CHIP	0.1uF		25V
C107		CERAMIC CHIP	0.1uF		25V	C181		TANTALUM CHIP		20%	16V
C108		CERAMIC CHIP	0.1uF		25V	C183	1-163-038-00	CERAMIC CHIP	0.1uF		25V
C109	1-163-037-11	CERAMIC CHIP	0.022uF	10%	25V						
C111	1-164-344-11	CERAMIC CHIP	0.068uF	10%	25V	C184	1-117-970-11	ELECT CHIP	22uF	20%	10V
						C185	1-164-611-11	CERAMIC CHIP	0.001uF	10%	500V
C112	1-163-017-00	CERAMIC CHIP	0.0047uF	5%	50V	C187	1-104-913-11	TANTALUM CHIP	10uF	20%	16V
C113	1-109-982-11	CERAMIC CHIP	1uF	10%	10V	C188	1-163-021-11	CERAMIC CHIP	0.01uF	10%	50V
C115	1-164-489-11	CERAMIC CHIP	0.22uF	10%	16V	C189	1-163-989-11	CERAMIC CHIP	0.033uF	10%	25V
C116	1-163-037-11	CERAMIC CHIP	0.022uF	10%	25V						
C117	1-163-809-11	CERAMIC CHIP	0.047uF	10%	25V	C190	1-126-206-11	ELECT CHIP	100uF	20%	6.3V
						C191	1-163-038-00	CERAMIC CHIP	0.1uF		25V
C118	1-163-038-00	CERAMIC CHIP	0.1uF		25V	C196	1-163-038-00	CERAMIC CHIP	0.1uF		25V
C119	1-125-822-11	TANTALUM	10uF	20%	10V	C197	1-163-038-00	CERAMIC CHIP	0.1uF		25V
C121	1-125-822-11	TANTALUM	10uF	20%	10V						
C122	1-163-021-11	CERAMIC CHIP	0.01uF	10%	50V			< CONNECTOR >			
C123	1-163-038-00	CERAMIC CHIP	0.1uF		25V						
						CN101	1-569-479-51	CONNECTOR, FPC	C 21P		
C124	1-163-038-00	CERAMIC CHIP	0.1uF		25V	CN102	1-784-833-21	CONNECTOR,FFC	(LIF (NON-	ZIF)) 21	Р
C127		CERAMIC CHIP	0.1uF		25V	CN103	1-784-834-21				
C128		CERAMIC CHIP	0.01uF	10%	50V	CN104		CONNECTOR, FFC		,,	
C129		CERAMIC CHIP	0.47uF	10%	16V	CN110		PIN, CONNECTOR		D) 6P	
C130		CERAMIC CHIP	100PF	5%	50V			,	. (	-,	
0.00	00 20	02.0.000		0.70				< DIODE >			
C131	1-163-023-00	CERAMIC CHIP	0.015uF	5%	50V			1510521			
C132		CERAMIC CHIP	0.47uF	10%	16V	D101	8-719-988-61	DIODE 1SS355T	F-17		
C132		CERAMIC CHIP	0.47di 0.0047uF		50V	D181		DIODE F1J6TP	_ ''		
C134		CERAMIC CHIP	0.0047di 0.1uF	370	25V	D183		DIODE F1J6TP			
C135		CERAMIC CHIP	0.1uF		25V	2100	5 7 1 7 0 40 00	2.002 113011			
0100	1 100 000-00	CERTAINING OTHER	J. 1 UI		201						
C136	1-126-206-11	ELECT CHIP	100uF	20%	6.3V						

The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque  $\triangle$  sont critiques pour la sécurité

Ne les remplacer que par une pièce portant le neméro spécifié.



Dof No	Dort No.	Description			Domark	Dof No	Dort No	Description			Domark
Ref. No.	<u>Part No.</u>	<u>Description</u> < IC/TRANSISTOR	₹ >		<u>Remark</u>	Ref. No.	<u>Part No.</u>	Description			<u>Remark</u>
						R132	1-216-097-91	RES. CHIP	100K	5%	1/10W
IC101	8-752-080-95	IC CXA2523AR				R133	1-216-117-00		680K	5%	1/10W
IC103		TRANSISTOR FA	/\W1			R134	1-216-049-11		1K	5%	1/10W
IC121		IC CXD2654R	,,,,,,			R135	1-216-061-00		3.3K	5%	1/10W
IC121		IC TC7WU04FU	(TF12R)			R136	1-216-049-11		1K	5%	1/10W
IC124		IC MSM51V4400				100	1 210 047 11	KES, OIIII	TIX.	370	171000
10124	0-737-334-30	10 10151015104400	J-701J-K			R137	1-216-295-00	SHORT	0		
IC152	8-759-430-25	IC BH6511FS-E2	)			R140	1-216-029-00		150	5%	1/10W
IC171		IC BR24C02F-E2				R142	1-216-073-00		10K	5%	1/10W
IC181		IC MC74ACT08D				R143	1-216-073-00		10K	5%	1/10W
IC192		IC BA033FP-E2	, III.Z			R144	1-216-025-00		100	5%	1/10W
.0.72	0 707 100 72	27.00011 22					. 2.0 020 00			0,0	.,
		< COIL/SHORT >				R145	1-216-073-00	METAL CHIP	10K	5%	1/10W
						R146	1-216-037-00		330	5%	1/10W
L101	1-414-813-11	FERRITE	0uH			R147	1-216-025-00	RES, CHIP	100	5%	1/10W
L102	1-414-813-11		0uH			R148	1-216-045-00		680	5%	1/10W
L103	1-414-813-11	FERRITE	0uH			R149	1-216-073-00	METAL CHIP	10K	5%	1/10W
L105	1-414-813-11	FERRITE	0uH								
L106	1-414-813-11	FERRITE	0uH			R150	1-216-295-00	SHORT	0		
						R151	1-216-073-00	METAL CHIP	10K	5%	1/10W
L121	1-414-813-11	FERRITE	0uH			R152	1-216-073-00	METAL CHIP	10K	5%	1/10W
L122	1-414-813-11	FERRITE	0uH			R158	1-216-097-91	RES, CHIP	100K	5%	1/10W
L151	1-412-029-11	INDUCTOR CHIP	10uH			R159	1-216-097-91	RES, CHIP	100K	5%	1/10W
L152	1-412-029-11	INDUCTOR CHIP	10uH								
L153	1-412-032-11	INDUCTOR CHIP	100uH			R160	1-216-295-00	SHORT	0		
						R161	1-216-057-00	METAL CHIP	2.2K	5%	1/10W
L154	1-412-032-11	INDUCTOR CHIP	100uH			R162	1-216-057-00	METAL CHIP	2.2K	5%	1/10W
L161	1-414-813-11	FERRITE	0uH			R163	1-216-057-00	METAL CHIP	2.2K	5%	1/10W
L162	1-414-813-11	FERRITE	0uH			R164	1-216-045-00	METAL CHIP	680	5%	1/10W
L181	1-216-295-00	SHORT	0								
						R165	1-216-097-91		100K	5%	1/10W
		< TRANSISTOR >				R166	1-220-149-11		2.2	10%	1/2W
						R167	1-216-065-00		4.7K	5%	1/10W
Q101	8-729-028-91		DTA144E			R169	1-219-724-11		1	1%	1/4W
Q102	8-729-026-53		2SA1576		R	R170	1-216-073-00	METAL CHIP	10K	5%	1/10W
Q103	8-729-028-99		RN1307-								
Q104	8-729-028-99		RN1307-			R171	1-216-073-00		10K	5%	1/10W
Q162	8-729-101-07	TRANSISTOR	2SB798-E	)L		R173	1-216-121-00		1M	5%	1/10W
0440		TD 441010T0D	D.T. 4 4 4 5			R175	1-216-065-00		4.7K	5%	1/10W
Q163	8-729-028-91		DTA144E			R177	1-216-061-00		3.3K	5%	1/10W
Q181	8-729-018-75		2SJ278M			R179	1-216-085-00	METAL CHIP	33K	5%	1/10W
Q182	8-729-017-65	FEI	2SK1764	CY.		D100	1 21/ 072 00	METAL CLUD	101/	F0/	1/10/1/
		< RESISTOR >				R180 R182	1-216-073-00 1-216-089-00		10K 47K	5% 5%	1/10W 1/10W
		< RESISTOR >				R183	1-216-089-00	,	47K 47K	5%	1/10W
R103	1-216-049-11	DEC CHID	1K	5%	1/10W	R184	1-216-073-00		47K 10K	5%	1/10W
R103	1-216-049-11		10K	5%	1/10W	R185	1-216-073-00		22K	5%	1/10W
R105	1-216-065-00		4.7K	5%	1/10W	100	1-210-001-00	WETAL OTT	221	370	17 10 00
R106	1-216-133-00		3.3M	5%	1/10W	R186	1-216-089-00	RES CHIP	47K	5%	1/10W
R100	1-216-133-00		470K	5%	1/10W	R188	1-216-073-00	•	10K	5%	1/10W
107	1 210 113 00	WEINE OIII	47010	370	171000	R189	1-216-073-00		10K	5%	1/10W
R109	1-216-295-00	SHORT	0			R190	1-216-073-00		10K	5%	1/10W
R110	1-216-073-00		10K	5%	1/10W	R195	1-216-073-00		10K	5%	1/10W
R111	1-216-295-00		0	070	171000	1(170	1 210 070 00	WEINE OIII	1010	070	17 10 11
R112	1-216-089-00		47K	5%	1/10W	R196	1-216-295-00	SHORT	0		
R113	1-216-049-11		1K	5%	1/10W	R197	1-216-295-00		0		
	. 2.0 0.7	11207 01111		0,0	.,	,	. 210 270 00	01.0111	Ü		
R115	1-216-049-11	RES, CHIP	1K	5%	1/10W			< SWITCH >			
R117	1-216-113-00		470K	5%	1/10W						
R120	1-216-025-00	RES, CHIP	100	5%	1/10W	S101	1-762-596-21	SWITCH, PUSH	(1 KEY) (LII	MIT IN)	
R121	1-216-097-91		100K	5%	1/10W	S102		SWITCH, PUSH	. , .	,	
R123	1-216-295-00		0						(REFLÉCT I	DET, PRO	TECT DET)
						*******	*********	******			
R124	1-216-025-00	RES, CHIP	100	5%	1/10W						
R125	1-216-025-00	RES, CHIP	100	5%	1/10W						
R127	1-216-025-00	RES, CHIP	100	5%	1/10W						
R129	1-216-295-00	SHORT	0								
R131	1-216-073-00	METAL CHIP	10K	5%	1/10W	l					

## MAIN

Ref. No.	Part No.	<u>Description</u>			Remark	Re	ef. No.	Part No.	Description	<u>on</u>			<u>Remark</u>
*		MAIN BOARD, CO					C431	1-126-966-11	ELECT		33uF	20%	50V
*		MAIN BOARD, CO	,	,			C432	1-128-551-11	FLECT		22uF	20%	25V
	A-4724-031-A	********	,	ili, Oit)		1	C441	1-126-933-11			100uF	20%	16V
						1	C442	1-162-306-11			0.01uF	20%	16V
	7-685-872-09	SCREW +BVTT 3	(S) 8X				C443	1-162-306-11			0.01uF	20%	16V
	7 000 072 07	SOREW IDVIT S	/(U (U)			1	C461	1-126-964-11			10uF	20%	50V
		< BATTERY >				1	C466	1-126-964-11			10uF	20%	50V
BT406	1-528-887-11	BATTERY, LITHIU	IM SECOND	ARY			C500	1-131-347-00	TANTAI IJ	M	1uF	10%	35V
D1 100	1 020 007 11	DATE LATE	W OLOOND	,		1	C512	1-164-159-11			0.1uF	1070	50V
		< CAPACITOR >					C516	1-164-159-11			0.1uF		50V
						1	C519	1-162-294-31			0.001uF	10%	50V
C101	1-162-290-31	CERAMIC	470PF	10%	50V	1	C531	1-162-282-31			100PF	10%	50V
C102	1-126-964-11		10uF	20%	50V								
C181	1-128-551-11	ELECT	22uF	20%	25V		C533	1-162-282-31	CERAMIC		100PF	10%	50V
C182	1-162-600-11	CERAMIC	0.0047uF	30%	16V		C562	1-164-159-11	CERAMIC		0.1uF		50V
C183	1-162-294-31	CERAMIC	0.001uF	10%	50V		C571	1-162-282-31	CERAMIC		100PF	10%	50V
							C572	1-162-282-31	CERAMIC		100PF	10%	50V
C184	1-126-963-11	ELECT	4.7uF	20%	50V		C573	1-162-282-31	CERAMIC		100PF	10%	50V
C185	1-162-282-31	CERAMIC	100PF	10%	50V								
C201	1-162-290-31	CERAMIC	470PF	10%	50V		C575	1-162-282-31	CERAMIC		100PF	10%	50V
C202	1-126-964-11	ELECT	10uF	20%	50V		C594	1-162-294-31	CERAMIC		0.001uF	10%	50V
C281	1-128-551-11	ELECT	22uF	20%	25V		C595	1-162-294-31	CERAMIC		0.001uF	10%	50V
							C597	1-162-294-31	CERAMIC		0.001uF	10%	50V
C282	1-162-600-11	CERAMIC	0.0047uF	30%	16V		C598	1-164-159-11	CERAMIC		0.1uF		50V
C283	1-162-294-31	CERAMIC	0.001uF	10%	50V								
C284	1-126-963-11	ELECT	4.7uF	20%	50V		C599	1-164-159-11	CERAMIC		0.1uF		50V
C285	1-162-282-31	CERAMIC	100PF	10%	50V		C601	1-162-306-11	CERAMIC		0.01uF	20%	16V
C300	1-126-934-11	ELECT	220uF	20%	10V		C611	1-164-159-11			0.1uF		50V
							C612	1-126-963-11	ELECT		4.7uF	20%	50V
C301	1-164-159-11	CERAMIC	0.1uF		50V		C613	1-162-306-11	CERAMIC		0.01uF	20%	16V
C302	1-126-934-11	ELECT	220uF	20%	10V								
C303	1-164-159-11	CERAMIC	0.1uF		50V		C912	1-164-159-11	CERAMIC		0.1uF		50V
C304	1-164-159-11	CERAMIC	0.1uF		50V		C913	1-164-159-11	CERAMIC		0.1uF		50V
C305	1-164-159-11	CERAMIC	0.1uF		50V								
									< CONNE	CTOR >			
C306	1-126-934-11	ELECT	220uF	20%	10V								
C307	1-164-159-11	CERAMIC	0.1uF		50V		CN406	1-568-683-11	PIN, CON	NECTOR	R (PC BAOF	RD) 2P	
C308	1-126-934-11	ELECT	220uF	20%	10V	1	CN502	1-568-934-11					
C350	1-164-159-11		0.1uF		50V	1		1-691-770-11	(			, -	
C351	1-162-205-31	CERAMIC	18PF	5%	50V		CNS411	1-784-418-11	CONNECT	OR, FF	C (LIF(NON	-ZIF) 21P	)
C352	1-162-203-31	CERAMIC	15PF	5%	50V		CNS421	1-779-287-11	CONNECT	OR. FF	C (LIF(NON	-7IF))19F	)
C370	1-126-933-11		100uF	20%	16V			1-784-417-11					
C371	1-126-934-11		220uF	20%	10V					,		,	
C380	1-164-159-11	CERAMIC	0.1uF		50V				< DIODE :	>			
C381	1-164-159-11	CERAMIC	0.1uF		50V								
							D390	8-719-911-19	DIODE 1	SS119			
C385	1-164-159-11	CERAMIC	0.1uF		50V		D391	8-719-911-19	DIODE 1	SS119			
C386	1-164-159-11	CERAMIC	0.1uF		50V		D401	8-719-210-21	DIODE 1	1EQS04	4		
C398	1-162-282-31	CERAMIC	100PF	10%	50V		D402	8-719-210-21	DIODE 1	1EQS04	4		
C401	1-126-936-11	ELECT	3300uF	20%	16V		D403	8-719-210-21	DIODE 1	1EQS04	4		
C402	1-164-159-11	CERAMIC	0.1uF		50V								
							D404	8-719-210-21			4		
C404	1-126-933-11	ELECT	100uF	20%	16V		D406	8-719-911-19	DIODE 1	SS119			
C406	1-124-252-00	ELECT	0.33uF	20%	50V		D408	8-719-024-99					
C407	1-162-294-31		0.001uF	10%	50V		D409	8-719-210-21	DIODE 1	1EQS04	4		
C411	1-126-939-11	ELECT	10000uF	20%	16V		D.444	0.710.004.00	DIODE 1	1500 N	ITAOD		
C412	1 16/ 150 11	CEDANIC	Λ 1υE		50\/	1	D411	8-719-024-99					
C412	1-164-159-11		0.1uF	200/	50V	1	D412	8-719-024-99					
C416	1-126-926-11		1000uF	20%	10V	1	D421	8-719-024-99					
C421 C422	1-164-159-11 1-164-159-11		0.1uF 0.1uF		50V 50V	1	D422 D431	8-719-109-81 8-719-911-19			DDZ		
UTZZ	1-10 <del>1</del> -137-11	OFIVUINIO	o. rui		30 V		ונדע	0-717-711-17	ו אמטומ	55117			
C423	1-128-576-11		100uF	20%	63V	1	D432	8-719-911-19					
C424	1-164-159-11		0.1uF		50V	1	D433	8-719-911-19					
C425	1-126-967-11		47uF	20%	50V	1	D461	8-719-024-99					
C426	1-128-551-11	ELECT	22uF	20%	63V		D462	8-719-024-99	DIODE 1	1ES2-N	ITA2B		

## MAIN

Ref. No.	Part No.	Description			<u>Remark</u>	Ref. No.	Part No.	Description			Remark
D466	8-719-024-99	DIODE 11ES2-N	ITA2B			R189	1-249-411-11		330	5%	1/4W
D4/7	0.710.004.00	DIODE 11500 A	ITAOD			R201	1-249-417-11		1K	5%	1/4W
D467		DIODE 155110	HA2B			R202	1-249-441-11		100K	5%	1/4W
D911	8-719-911-19	DIODE 1SS119				R206 R281	1-249-430-11		12K 10K	5% 5%	1/4W 1/4W
		< INDUCTOR >				RZ81	1-249-429-11	CARBON	TUK	5%	1/400
						R282	1-249-429-11	CARBON	10K	5%	1/4W
FB356	1-412-473-21	INDUCTOR (SMA	LL TYPE)			R283	1-249-433-11		22K	5%	1/4W
FB357	1-412-473-21	INDUCTOR (SMA	LL TYPE)			R284	1-247-864-11	CARBON	24K	5%	1/4W
FB358	1-412-473-21	INDUCTOR (SMA	LL TYPE)	(US, CNE	))	R285	1-249-417-11	CARBON	1K	5%	1/4W
						R286	1-249-417-11	CARBON	1K	5%	1/4W
		< IC >									
						R287	1-249-437-11		47K	5%	1/4W
IC301		IC UDA1341TS/				R288	1-249-415-11		680	5%	1/4W
IC351		IC SN74HCU04	AN			R289	1-249-411-11		330	5%	1/4W
IC381		IC M5218AL				R351	1-247-903-00		1M	5%	1/4W
IC386 IC401		IC M5218AL				R352	1-249-413-11	CARBON	470	5%	1/4W
10401	8-759-445-59	IC BAU331				R355	1-249-407-11	CADDON	150	5%	1/4W
IC406	8-759-481-02	IC M420141				R356	1-249-407-11		220	5% 5%	1/4W
IC408	8-759-231-53					R391	1-249-441-11		100K	5%	1/4W
IC411	8-759-633-42					R392	1-247-883-00		150K	5%	1/4W
IC421	8-759-822-09					K372	1-247-003-00	CARBON	IJUK	370	1/4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4
10441	0-737-022-07	IC EDIOTI				R406	1-249-409-11	CARBON	220	5%	1/4W
IC501	8-759-577-40	IC M30620MC-4	400FP			R407	1-249-429-11		10K	5%	1/4W
IC601		IC SN74HCU04				R420	1-247-881-00		120K	5%	1/4W
IC611		IC GP1F38R (DI		IT)		R422	1-249-441-11		100K	5%	1/4W
		(2.		- /		R423	1-249-409-11		220	5%	1/4W
		< JACK >									
						R424	1-249-409-11	CARBON	220	5%	1/4W
J101	1-784-429-11	JACK, PIN 4P (LI	NE (ANAL	.OG) IN/O	UT)	R431	1-247-807-31		100	5%	1/4W
						R432	1-249-826-11		620	5%	1/4W
		< COIL >				R433	1-247-822-11		430	5%	1/4W
						R434	1-249-433-11	CARBON	22K	5%	1/4W
L450	1-410-509-11		10uH			5.405		0.1.0.0.1.	=	=0.	
L451	1-410-509-11		10uH			R435	1-249-438-11		56K	5%	1/4W
L611	1-410-509-11	INDUCTOR	10uH			R436	1-247-891-00		330K	5%	1/4W
		TDANGICTOD				R437	1-249-417-11		1K	5%	1/4W
		< TRANSISTOR >	>			R441	1-249-431-11		15K	5%	1/4W
Q191	0 720 000 74	TRANSISTOR	DTC143	тс		R442	1-249-433-11	CARBON	22K	5%	1/4W
Q191 Q291		TRANSISTOR	DTC143			R443	1-249-434-11	CADRON	27K	5%	1/4W
Q390		TRANSISTOR	UN4111			R509	1-249-441-11		100K	5%	1/4W
Q340 Q441		TRANSISTOR	DTC114			R513	1-247-903-00		100K	5%	1/4W
Q441 Q442		TRANSISTOR	2SA117			R513	1-249-429-11		10K	5%	1/4W
Q112	0-727-117-70	TRANSISTOR	ZJATT	J-111 L		R530	1-249-429-11		10K	5%	1/4W
Q911	8-729-119-78	TRANSISTOR	2SC403	SP-51		11330	1 277 727 11	ONINDON	TOIC	370	17 4 4 4
47.11	0 /2/ / / 0		200.00	o. o.		R531	1-249-429-11	CARBON	10K	5%	1/4W
		< RESISTOR >				R532	1-249-429-11	CARBON	10K	5%	1/4W
						R533	1-249-429-11	CARBON	10K	5%	1/4W
R81	1-249-441-11	CARBON	100K	5%	1/4W	R542	1-249-429-11	CARBON	10K	5%	1/4W
					(US, CND)	R543	1-249-429-11		10K	5%	1/4W
R82	1-249-441-11	CARBON	100K	5%	1/4W						
				(EXCEP	T US, CND)	R550	1-249-429-11	CARBON	10K	5%	1/4W
R87	1-249-441-11	CARBON	100K	5%	1/4W	R551	1-249-429-11	CARBON	10K	5%	1/4W
R101	1-249-417-11	CARBON	1K	5%	1/4W	R553	1-249-429-11	CARBON	10K	5%	1/4W
						R559	1-249-429-11	CARBON	10K	5%	1/4W
R102	1-249-441-11		100K	5%	1/4W	R560	1-249-429-11	CARBON	10K	5%	1/4W
R106	1-249-430-11	CARBON	12K	5%	1/4W						
R181	1-249-429-11		10K	5%	1/4W	R566	1-249-441-11		100K	5%	1/4W
R182	1-249-429-11		10K	5%	1/4W	R568	1-249-429-11		10K	5%	1/4W
R183	1-249-433-11	CARBON	22K	5%	1/4W	R569	1-249-429-11		10K	5%	1/4W
		0.1555				R571	1-249-441-11	CARBON	100K	5%	1/4W
R184	1-247-864-11		24K	5%	1/4W	DE==	1 0 40 400 1	CADDOM	401/	F0:	4/40**
R185	1-249-417-11		1K	5%	1/4W	R573	1-249-429-11		10K	5%	1/4W
R186	1-249-417-11		1K	5%	1/4W	R574	1-249-429-11		10K	5%	1/4W
R187	1-249-437-11		47K	5%	1/4W	R575	1-249-429-11		10K	5%	1/4W
R188	1-249-415-11	CAKRON	680	5%	1/4W	R577	1-249-429-11	CAKBON	10K	5%	1/4W
						I .					

## MAIN PANEL PANEL 2

Ref. No.	Part No.	Description			<u>Remark</u>	Ref. No.	Part No.	<u>Description</u>			<u>Remark</u>
R581	1-249-441-11	CARBON	100K	5%	1/4W	Q767	8-729-900-74	TRANSISTOR	DTC143T	S	
				(EXCEP	T US, CND)			< RESISTOR >			
R582	1-249-441-11	CARBON	100K	5%	1/4W						
					(US, CND)	R702	1-249-421-11		2.2K	5%	1/4W
R592	1-249-429-11		10K	5%	1/4W	R703	1-247-843-11		3.3K	5%	1/4W
R593	1-249-429-11		10K	5%	1/4W	R704	1-249-425-11		4.7K	5%	1/4W
R594	1-249-429-11		10K	5%	1/4W	R705	1-249-429-11	CARBON	10K	5%	1/4W
R595	1-249-429-11	CARBON	10K	5%	1/4W	R706	1-249-435-11	CARBON	33K	5%	1/4W
R597	1-249-429-11	CARBON	10K	5%	1/4W	R712	1-249-421-11		2.2K	5%	1/4W
R613	1-247-895-00		470K	5%	1/4W	R713	1-247-843-11		3.3K	5%	1/4W
R614	1-249-437-11		47K	5%	1/4W	R714	1-249-425-11		4.7K	5%	1/4W
R623	1-247-895-00		470K	5%	1/4W	10714	1 247 425 11	ONTO	7.710	370	17-7-00
R624	1-249-437-11		47K	5%	1/4W	R722	1-249-421-11	CARBON	2.2K	5%	1/4W
11024	1 247 437 11	OTTO	7710	370	17 7 00	R723	1-247-843-11		3.3K	5%	1/4W
R801	1-249-426-11	CADRON	5.6K	5%	1/4W	R724	1-249-425-11		4.7K	5%	1/4W
R803	1-249-425-11		4.7K	5%	1/4W	R725	1-249-429-11		10K	5%	1/4W
R804	1-249-429-11		10K	5%	1/4W	R741	1-249-429-11		220	5%	1/4W
						K/41	1-249-409-11	CARDON	220	370	1/4 VV
R911	1-249-425-11		4.7K	5%	1/4W	D740	1 040 400 11	CADDON	220	E0/	1/4/4/
R912	1-249-437-11	CARBON	47K	5%	1/4W	R742	1-249-409-11		220	5%	1/4W
		VIDDATOD				R760	1-247-807-31		100	5%	1/4W
		< VIBRATOR >				R761	1-247-807-31		100	5%	1/4W
						R762	1-247-807-31		100	5%	1/4W
X351		VIBRATOR, CRYS	-			R763	1-247-807-31	CARBON	100	5%	1/4W
X513		VIBRATOR, CERA									
******	******	******	*****	******	*****	R767	1-249-441-11	CARBON	100K	5%	1/4W
						R769	1-247-843-11	CARBON	3.3K	5%	1/4W
*	A-4724-590-A	PANEL BOARD, (									
		******	*******	¢				< SWITCH >			
*	4-216-341-01					S701		SWITCH, KEYBO		EC)	
*	4-921-941-01	CUSHION (FL)				S702		SWITCH, KEYBO	` '		
						S703	1-762-875-21	SWITCH, KEYBO	ARD (►►)		
		< CAPACITOR >				S704	1-762-875-21	SWITCH, KEYBO	ARD (◀◀)		
						S705	1-762-875-21	SWITCH, KEYBO	ARD (▮▮)		
C701	1-126-153-11	ELECT	22uF	20%	6.3V						
C760	1-164-159-11	CERAMIC	0.1uF		50V	S706	1-762-875-21	SWITCH, KEYBO	ARD (▷)		
C761	1-162-294-31	CERAMIC	0.001uF	10%	50V	S711	1-762-875-21	SWITCH, KEYBO	ARD (MEN	J/NO)	
C762	1-162-294-31	CERAMIC	0.001uF	10%	50V	S712	1-762-875-21	SWITCH, KEYBO	ARD (YES)		
C763	1-162-294-31	CERAMIC	0.001uF	10%	50V	S713		ENCODER, ROTA			
								· (I	<b>I</b> AMS I	►►I, PUS	SH ENTER)
C764	1-164-159-11	CERAMIC	0.1uF		50V	S714	1-762-875-21	SWITCH, KEYBO	ARD (CLEA	R)	,
C765	1-126-153-11		22uF	20%	6.3V				`	,	
C766	1-164-159-11	CERAMIC	0.1uF		50V	S721	1-762-875-21	SWITCH, KEYBO	ARD (EJEC	T 合)	
C769	1-162-215-31		47PF	5%	50V	S722		SWITCH, KEYBO	•	,	
						S723		SWITCH, KEYBO	•	,	
		< CONNECTOR >				S724		SWITCH, KEYBO			
						S725		SWITCH, KEYBO			AY/CHAR)
CNS70	1 1-778-449-11	CONNECTOR, FFO	C/FPC 19P						(		,
		CONNECTOR, BO			)	S731	1-571-427-11	SWITCH, SLIDE	(INPUT)		
		, ,						*******	,	*****	*****
		< LED >									
						*	1-673-305-11	PANEL 2 BOARD			
D741	8-719-046-44	LED SEL5221S	<b>(</b>					******			
D742		LED SEL5421E-	. ,	)							
				,				< CAPACITOR >			
		< FLUORESCENT	INDICATO	R TUBE :	>						
						C781	1-124-584-00	ELECT	100uF	20%	10V
FL771	1-517-804-11	INDICATOR TUBE	E. FLUORE	SCENT		C782	1-162-306-11		0.01uF	20%	16V
			_,	002		0.02	. 102 000 11	02.0.000	0.0.4	2070	
		< IC >						< CONNECTOR >			
		(10)						(001111201011)			
IC761	8-759-426-98	IC MSM9202-02	2GS-K			* CNP702	1-569-799-11	PLUG, CONNECT	OR 5P		
10701	5 . 5 , 120 /0	.5				5111 702	. 55, , , , 11	. 200, 001414201	301		
		< TRANSISTOR >	<b>,</b>					< LED >			
Q741	8-729-422-57	TRANSISTOR	UN4111			D751	8-719-046-44	LED SEL5221S	(I/(I))		
Q742		TRANSISTOR	UN4111						,		
12	, . <b></b> 0/		2								

<b>N</b> I		
N		
	_	

SW

**TRANS** 

Ref. No.	Part No.	<u>Description</u>			<u>Remark</u>	Ref. No.	Part No.	<u>Description</u>	<u>Remark</u>
		< IC >						MISCELLANEOUS **********	
IC781	8-749-013-92	IC GP1UC7X (■	1)			9	1 700 510 11	WIRE (FLAT TYPE) (19 CORE)	
		< TRANSISTOR >	<b>&gt;</b>			57 58	1-790-512-11 1-790-513-11	WIRE (FLAT TYPE) (21 CORE) WIRE (FLAT TYPE) (23 CORE)	
Q751	8-729-422-57	TRANSISTOR	UN4111			61 <b>∆</b> 63		BEAD, FERRITE (WITH CASE) CORD, POWER (UK)	
		< RESISTOR >							
R726	1-249-435-11	CARBON	33K	5%	1/4W	<b>△</b> 63 <b>△</b> 63		CORD, POWER (AEP, SP) CORD, POWER (US, CND)	
R751	1-249-409-11	CARBON	220	5%	1/4W	* 258	1-667-954-11	FLEXIBLE BOARD	
R781 R782	1-249-401-11 1-247-807-31		47 100	5% 5%	1/4W 1/4W	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		OPTICAL PICK-UP KMS-260A/J1	NP
K/82	1-24/-80/-31	CARBON	100	5%	1/4 VV	HK901	1-300-302-11	HEAD, OVER WRITE	
		< SWITCH >				M101		MOTOR ASSY, SPINDLE	
S726	1 762 075 21	SWITCH, KEYBO	VDD (I/(p)			M102 M103		MOTOR ASSY, SLED MOTOR ASSY, LOADING	
		********	( /	******	******	S102		SWITCH, PUSH (2 KEY)	
						0.02	. 702 . 10 2 .	(REFLECT DET, I	PROTECT DET)
*	1-668-111-11	SW BOARD ******				<b> ⚠</b> T901	1-433-697-11	TRANSFORMER, POWER (US, C	ND)
		***					1-433-698-11	TRANSFORMER, POWER (AEP, L	IK)
		< CONNECTOR >				<u></u>		TRANSFORMER, POWER (SP)	, it's
011101						******	*********	************	*****
CN601	1-506-486-11	PIN, CONNECTOR	R /P					******	
		< SWITCH >						HARDWARE LIST	
								*******	
S601 S602		SWITCH, PUSH ( SWITCH, PUSH (	, ,		ION)	#1	7 405 414 70	SCREW +BVTP 3X8 TYPE2 N-S	
S604			, ,		)	#1		SCREW +B 2X5	
S604 1-771-264-11 SWITCH, PUSH (DETECTION)(1 KEY) (PB POSITION)						#4		SCREW +B 2X8	
***************					#5		SCREW, PRECISION +P 1.7X2.5		
*	1 672 206 11	TRANS BOARD				#6	7-685-533-19	SCREW +BTP 2.6X6 TYPE2 N-S	
	1-073-300-11	******				#7	7-685-133-19	SCREW +P 2.6X6 TYPE2 NON-SI	LIT
		0.00.00.00				******	*********	**********	*****
		< CAPACITOR >					ACCESSORIES	& PACKING MATERIALS	
<b> △ C901</b>	0.0022uF 20% 250V				250V	*********			
<b>△</b> C902	1-113-920-11	CERAMIC	0.0022uF	20%	250V			DELICITE COLUMNICED (DIA DO	-51
		< CONNECTOR >						REMOTE COMMANDER (RM-D3) CORD, OPTICAL PLUG	)P)
		< CONNECTOR >						CORD, CONNECTION	
* CN901	1-580-230-11	PIN, CONNECTOR	R (PC BOAF	RD) 2P				MANUAL, INSTRUCTION (ENGLI	,
		< LINE FILTER >					3-866-678-21	MANUAL, INSTRUCTION (FRENC PORTUGUES	CH, SPANISH, SE) (CND, AEP)
<b> ∆</b> LF901	1-411-547-11	FILTER, LINE					3-866-678-31	MANUAL, INSTRUCTION (GERM	AN. DUTCH.
		< RELAY >						•	TALIAN) (AEP)
å DV011	1 7/5 224 11							COVER, BATTERY (for RM-D30P	, , ,
<b> ≜</b> RY911	1-765-324-11	RELAY							
		< POWER TRANS	SFORMER >	>					
<b> ∆</b> T901	1-433-702-11	TRANSFORMER,	POWER (U	JS, CND)					
<b>△</b> T901		TRANSFORMER,	•						
<b></b>		TRANSFORMER, TRANSFORMER,	•	,					
Δ. 1910 Δ. T910		TRANSFORMER,	•						
				,,					
<b></b> ∆T910		TRANSFORMER,	`	,					

### MDS-M100